

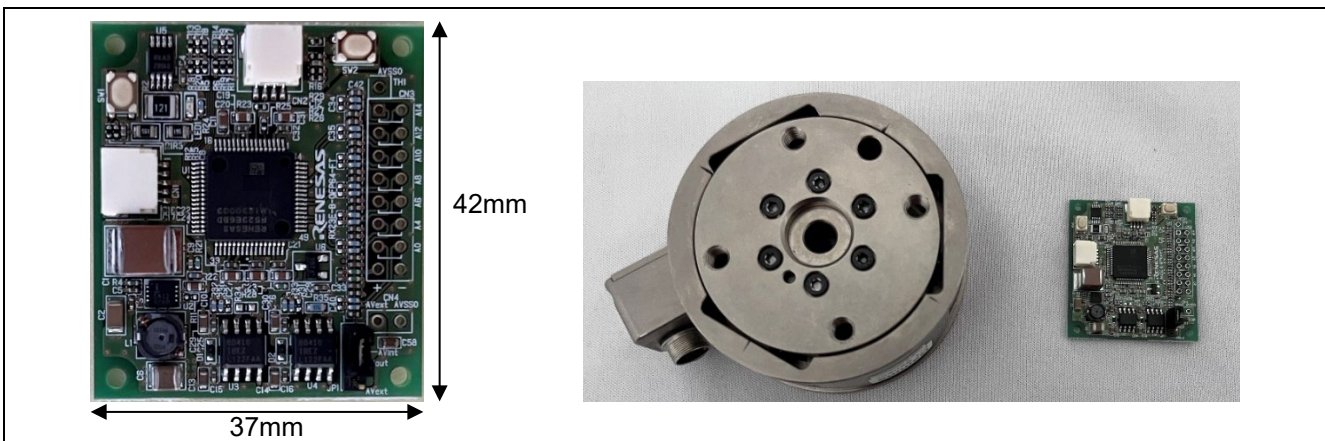
RX23E-B Group

Design and measurement of small board for 6-axis force sensor

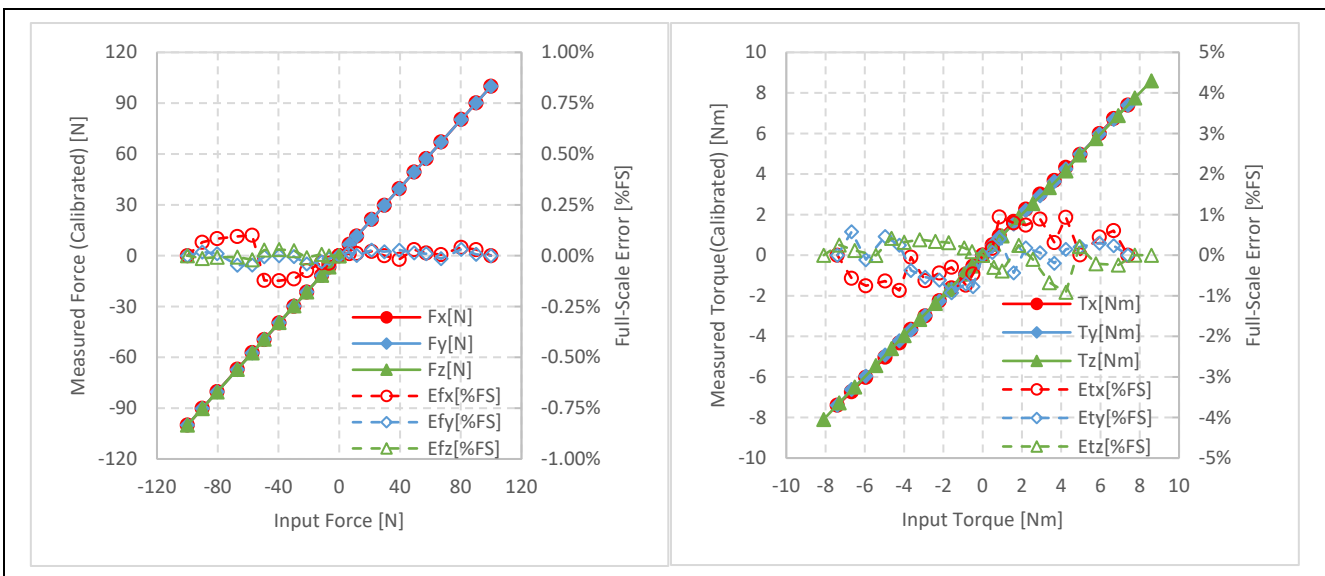
Introduction

This document describes the RX23E-B-QFP64-FT, which is a board for 6-axis force sensor using Renesas MCU, RX23E-B, and the example of the program which obtains three-dimensional force and torque by the strain gauge type 6-axis force sensor.

RX23E-B-QFP64-FT is miniaturized to be incorporated into a 6-axis force sensor, using RX23E-B, MCU with AFE in 64 pin LFQFP package, a DC/DC converter ISL85412 and LDO ISL80410 as power supply, and RAA7881582GSU as RS-485 driver.



This sample program uses the DSAD built in the RX23E-B to obtain output from six channels of the force sensor by scanning them. We have measured the 6-axis force sensor with RX23E-B-QFP64-FT and this program. The evaluation results are shown below. The force measurement error is within $\pm 0.25\%$ FS, and the torque measurement error is within $\pm 1\%$ FS, indicating that these errors are within the measurement uncertainty (max $\pm 1.25\%$ [FS]) of the force sensor used in this measurement.



Result of Force Measurement (Left) and Torque Measurement (Right)

Target Device

RX23E-B (R5F523E6BDFM)

Contents

| | |
|---|----|
| 1. Overview..... | 4 |
| 2. Package Contents | 6 |
| 3. Environment for Operation Confirmation | 6 |
| 4. Related Documents | 6 |
| 5. RX23E-B-QFP64-FT | 7 |
| 5.1 Board Specification | 7 |
| 5.2 Circuit Diagram..... | 8 |
| 5.3 Bill of Materials | 9 |
| 5.4 Pattern Diagram | 11 |
| 6. Force Sensor Measurement | 13 |
| 6.1 Force Sensor | 14 |
| 6.2 A/D Conversion of Strain Gauge Output | 15 |
| 6.3 Calculation Procedure | 16 |
| 6.4 Zero-Reset..... | 16 |
| 7. Communication..... | 17 |
| 7.1 QE for AFE | 17 |
| 7.2 Modbus RTU | 17 |
| 7.2.1 Supported Frame Format | 18 |
| 7.2.2 Data | 19 |
| 7.2.3 Operation..... | 21 |
| 8. Sample Program..... | 22 |
| 8.1 Overview of Operation..... | 22 |
| 8.2 Functions and Settings of MCU Used | 25 |
| 8.2.1 Force Sensor Measurement..... | 26 |
| 8.2.2 Communication | 28 |
| 8.2.3 LED1 and SW1..... | 32 |
| 8.2.4 E2 Data Flash..... | 32 |
| 8.3 Communication Control..... | 33 |
| 8.3.1 QE for AFE Communication | 33 |
| 8.3.2 Modbus RTU Communication | 34 |
| 8.3.2.1 Transmit/Receive Processing | 34 |
| 8.3.2.2 Receive Frame Processing | 37 |
| 8.4 Program Configuration | 39 |
| 8.4.1 Source File Configuration..... | 39 |

RX23E-B Group Design and measurement of small board for 6-axis force sensor

| | | |
|---------|--|----|
| 8.4.2 | Build Settings | 40 |
| 8.4.3 | Macro Definitions..... | 40 |
| 8.4.4 | Structures, Unions, and Enumeration Types | 42 |
| 8.4.5 | Functions..... | 45 |
| 8.4.5.1 | Common Functions | 45 |
| 8.4.5.2 | QE for AFE Version..... | 49 |
| 8.4.5.3 | Modbus Version | 50 |
| 9. | Importing a Project | 53 |
| 9.1 | Importing a Project into e2 studio..... | 53 |
| 9.2 | Importing a Project into CS+ | 54 |
| 10. | Operation on Renesas Solution Starter Kit for RX23E-B Board..... | 55 |
| 11. | Measurement Results with Sample Program | 59 |
| 11.1 | Memory Usage and Number of Execution Cycles | 59 |
| 11.1.1 | Build Conditions | 59 |
| 11.1.2 | Memory Usage | 59 |
| 11.1.3 | Number of Execution Cycle and Execution Time..... | 60 |
| 11.2 | Measurement Result | 61 |
| 11.2.1 | Measurement Appearance | 61 |
| 11.2.2 | Measurement Conditions | 62 |
| 11.2.3 | Measurement Result | 64 |
| | Revision History | 66 |

1. Overview

This document describes the example of measuring three-dimensional force and torque by using the small board RX23E-B-QFP64-FT containing RX23E-B and the 6-axis force sensor. The sample program conducts measurement with a force sensor, communicates with QE for AFE or Modbus host via an RS-485 half-duplex communication channel, and transmits measurement results.

Figure 1-1 shows the system of this example.

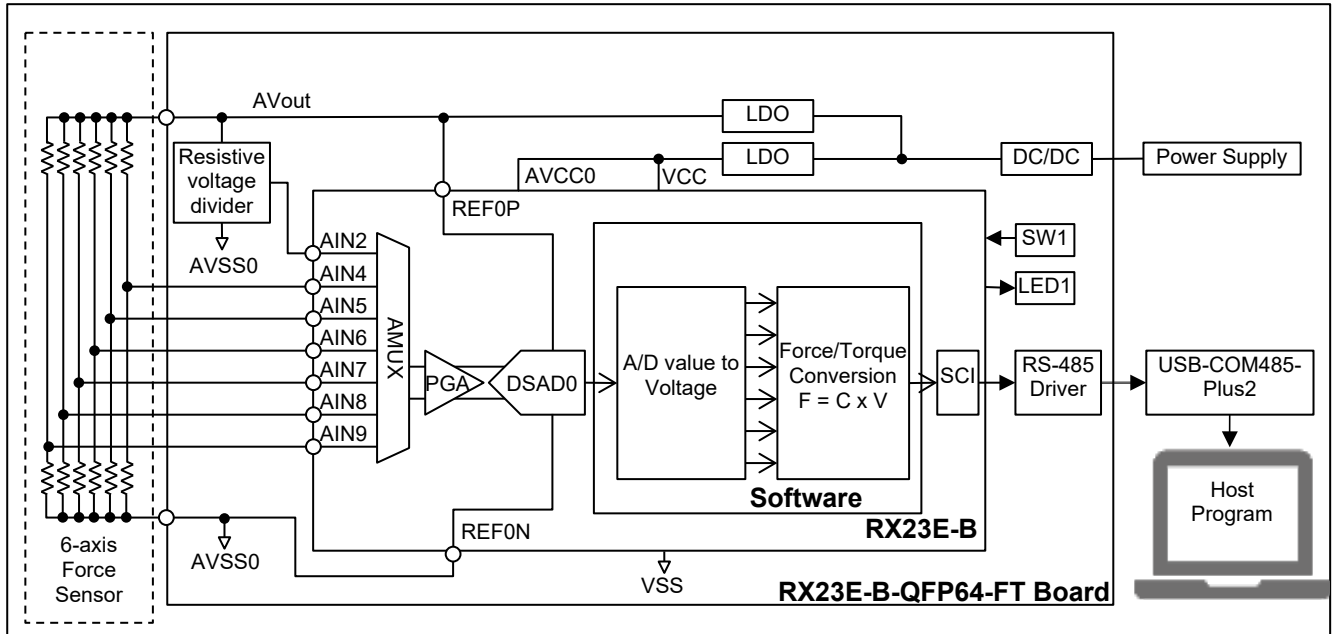


Figure 1-1 Example of Force Sensor Measurement System

In this example, the QE for AFE version sample program uses the application tab of QE for AFE to make various settings, conduct measurements, and display measurement results. The operable items are shown in Figure 1-2 and Table 1-1.

The Modbus version sample program operates similarly by making settings in Modbus Coil or Holding register listed in Table 7-6.

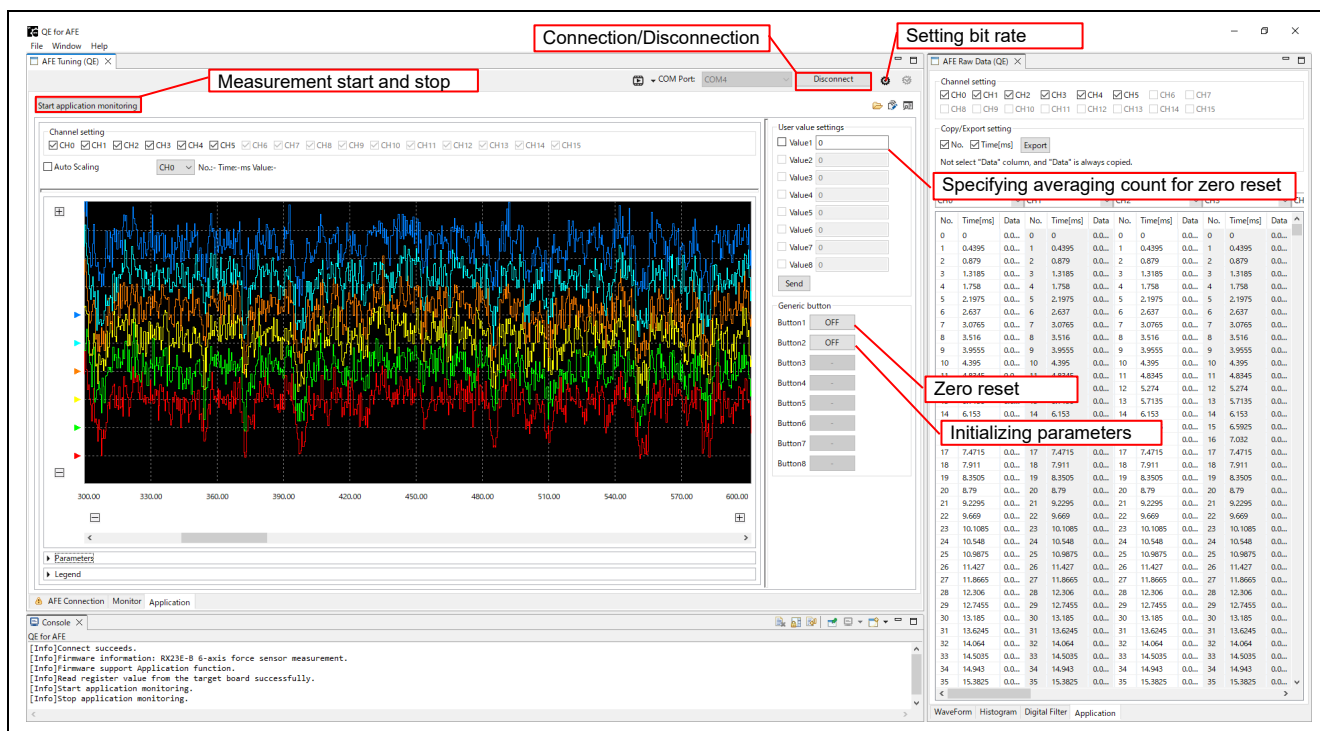


Figure 1-2 QE for AFE Application Tab Screen

Table 1-1 Operable Items

| Item | Operation | Remarks |
|---|---|---|
| Connection | QE for AFE: Connect/Disconnect button | |
| Start/stop of measurement | QE for AFE: Start/Stop button | LED1 OFF during measurement |
| Zero reset | QE for AFE: Button1 Board: SW1 | Enabled only during standby (LED1 ON) |
| Specifying the averaging count for zero reset | QE for AFE: Value1 64 to 512, default: 256 | |
| Parameter initialization | QE for AFE: Button2 Board: SW1 | Press SW1 and SW2 at the same time (reset), release SW2, and keep pressing SW1 until LED1 turns on. |

Note: Set the communication rate for QE for AFE to the communication rate in Table 7-1 Communication Conditions. Since QE for AFE is based on the full-duplex communication, transmission and reception may conflict and stop on instruction of measurement stop. If it stops, restart the MCU.

Also, changes to the parameters listed in Table 1-2 are retained in E2 data flash. For details, refer to structure st_prm_t in Table 8-27.

Table 1-2 Retained Parameters

| Item | Number of data stored |
|--------------------------------|-----------------------|
| Voltage-load conversion matrix | 1 set |
| DSAD0 offset correction value | 1 set |
| Averaging count for zero reset | 1 |

2. Package Contents

Table 2-1 Package Contents

| File/folder name | Description |
|-----------------------------|---------------------------------------|
| r01an6513jj0100-rx23e-b.pdf | This document (Japanese) |
| r01an6513ej0100-rx23e-b.pdf | This document (English) |
| BoardData | Board data of RX23E-B-QFP64-FT |
| rx23eb_force_qe | QE for AFE version sample project set |
| rx23eb_force_modbus | Modbus version sample project set |
| readme_j.txt | Package explanation (Japanese) |
| readme_e.txt | Package explanation (English) |

3. Environment for Operation Confirmation

Table 3-1 Environment for Operation Confirmation

| Item | Description | |
|---------------------------|---|--|
| Board | RX23E-B-QFP64-FT | |
| MCU | RX23E-B (R5F523E6BDFM) Power voltage (VCC, AVCC0): 5V Operating frequency (ICLK): 32MHz Peripheral operating frequency (PCLKB, PCLKC): 32MHz DSAD0 operating frequency (f _{OP}): 16MHz DSAD0 modulator clock frequency (f _{MOD}): 4MHz | |
| Force sensor | Manufacturer | ATI Industrial Automation |
| | Model | 9105-TWE-Gamma |
| | Calibration | SI-130-10 |
| | Measurement uncertainty | Fx: 1.00%, Fy: 1.25%, Fz: 0.75% Tx: 1.00%, Ty: 1.00%, Tz: 1.50% |
| RS-485/USB conversion BOX | Renesas RS-485-USB-POWER-BOX | |
| Host | QE for AFE version | Renesas QE for AFE V2.1.1 |
| | Modbus version | QModMaster 0.5.3-beta |
| IDE | Renesas e2 Studio Version 2023-04 Renesas RX Smart Configurator V23.4.0 | |
| Tool Chain | Renesas CC-RX V3.05.00 | |
| Emulator | Renesas E2 Emulator Lite | |

4. Related Documents

- R01UH0972 RX23E-B Group User's Manual: Hardware
- R01AN4359 RX family RX DSP Library Version 5.0
- R01AN6364 RX23E-B Group RSSKRX23E-B Board Control Program

5. RX23E-B-QFP64-FT

5.1 Board Specification

Table 5-1 RX23E-B-QFP64-FT Specifications

| Item | | Specification |
|----------------------------|--------|---|
| External dimensions | | 37mm × 42mm |
| Layer structure | | 4 layers, Laminating order: Signal - GND - Power supply - Signal |
| Board model name | | RX23E-B-QFP64-FT |
| Operating voltage | | Recommended operating voltage: 12 to 24V Maximum operating voltage: 26.4V |
| Current consumption | | 29.4mA typ. (Board alone) |
| Analog input specification | | Up to 7 differential inputs, 14 single ended inputs |
| Communication I/F | | RS-485, Half-duplex communication Maximum communication speed: 1Mbps Terminating resistor: 120Ω |
| Compatible emulator | | Renesas E2 Emulator, E2 Emulator Lite |
| User I/F | LED | LED1: Green |
| | Switch | SW1: For Zero-Reset SW2: For MCU reset |

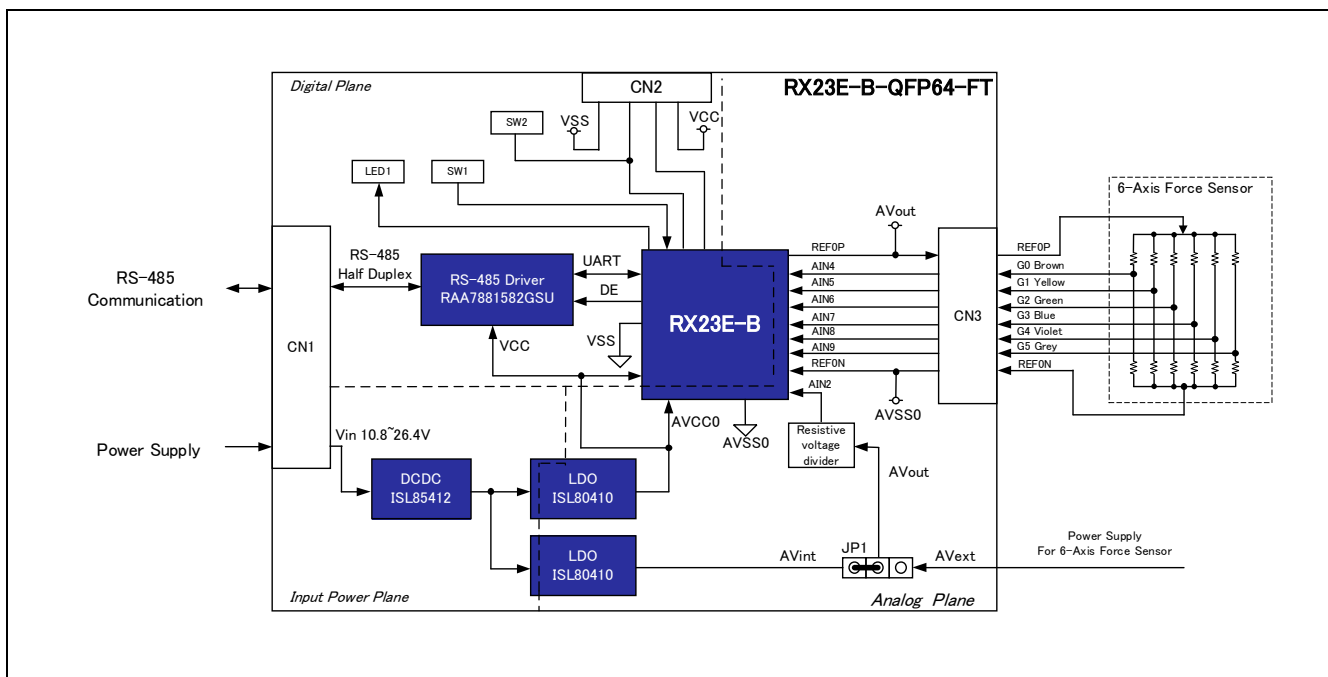


Figure 5-1 System Configuration

5.2 Circuit Diagram

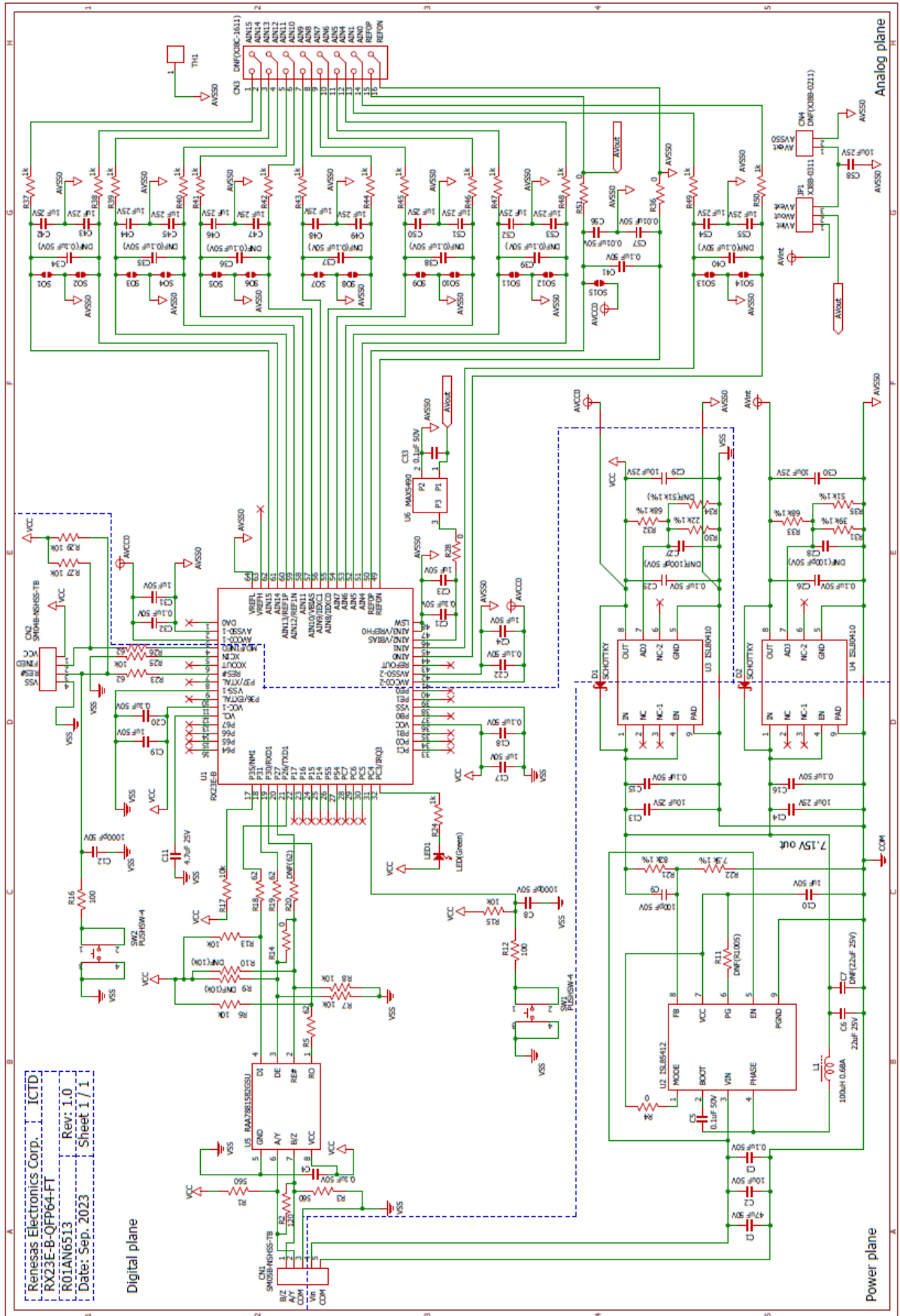


Figure 5-2 RX23E-B-QFP64-FT Circuit Diagram

5.3 Bill of Materials
Table 5-2 RX23E-B-QFP64-FT Bill of Materials (1/2)

| No. | Q'ty | Reference Designator | Description | Part Name | Manufacturer Part Name | Maker Name |
|-----|------|---|---------------------------|-------------------|------------------------|------------|
| 1 | 1 | U1 | RX23E-B | IC | R5F523E6BDFM | Renesas |
| 2 | 1 | U2 | DCDC | IC | ISL85412FRTZ | Renesas |
| 3 | 2 | U3,U4 | LDO | IC | ISL80410IBEZ | Renesas |
| 4 | 1 | U5 | RS-485 Driver | IC | RAA7881582GSU | Renesas |
| 5 | 1 | U6 | Resistive voltage divider | IC | MAX5490GA01000+T | Maxim |
| 6 | 1 | CN1 | 5pin | Connector | SM05B-NSHSS-TB | JST |
| 7 | 1 | CN2 | 4pin | Connector | SM04B-NSHSS-TB | JST |
| 8 | 1 | JP1 | 3pin | Pin header | XJ8B-0311 | Omron |
| 9 | 1 | C9 | 100pF 50V | Ceramic Capacitor | GCM1552C1H101JA01 | Murata |
| 10 | 2 | C8,C12 | 1000pF 50V | Ceramic Capacitor | GRM1552C1H102JA01 | Murata |
| 11 | 2 | C56,C57 | 0.01uF 50V | Ceramic Capacitor | GCM155R71H103KA55 | Murata |
| 12 | 14 | C3,C4,C5,C15, C16,C18,C20, C21,C22,C25, C26,C32,C33, C41 | 0.1uF 50V | Ceramic Capacitor | GRM155R71H104KE14 | Murata |
| 13 | 14 | C42,C43,C44, C45,C46,C47, C48,C49,C50, C51,C52,C53, C54,C55 | 1uF 25V | Ceramic Capacitor | C1005X5R1E105K050BC | TDK |
| 14 | 6 | C10,C17,C19, C23,C24,C31 | 1uF 50V | Ceramic Capacitor | C1608X5R1H105K080AB | TDK |
| 15 | 1 | C11 | 4.7uF 25V | Ceramic Capacitor | GRM188C81E475KE11 | Murata |
| 16 | 5 | C13,C14,C29, C30,C58 | 10uF 25V | Ceramic Capacitor | GRM188R61E106KA73 | Murata |
| 17 | 1 | C2 | 10uF 50V | Ceramic Capacitor | GCM31CD71H106KE35 | Murata |
| 18 | 1 | C6 | 22uF 25V | Ceramic Capacitor | GCM32EC71E226KE36 | Murata |
| 19 | 1 | C1 | 47uF 50V | Ceramic Capacitor | CKG57NX7R1H476M500JJ | TDK |
| 20 | 2 | D1,D2 | SCHOTTKY, VR=40V | Diode | RB521SM-40 | Rohm |
| 21 | 1 | L1 | 100uH 0.68A | Coil | CLF5030NIT-101M-D | TDK |
| 22 | 1 | LED1 | Green | LED | SML-E12P8W | ROHM |
| 23 | 5 | R4,R14,R28, R36,R51 | 0 | Resistor | RK73Z1ETTP | KOA |
| 24 | 4 | R5,R18,R19, R26 | 62 | Resistor | RK73B1ETTP620J | KOA |
| 25 | 2 | R12,R16 | 100 | Resistor | RK73B1ETTP101J | KOA |
| 26 | 1 | R2 | 120 | Resistor | RK73B2ETTD121J | KOA |
| 27 | 2 | R1,R3 | 560 | Resistor | RK73B2ATTD561J | KOA |

RX23E-B Group Design and measurement of small board for 6-axis force sensor

Table 5-3 RX23E-B-QFP64-FT Bill of Materials (2/2)

| No. | Q'ty | Reference Designator | Description | Part Name | Manufacturer Part Name | Maker Name |
|-----|------|---|-------------|------------------|------------------------|--------------------------|
| 28 | 15 | R24,R37,R38,R39, R40,R41,R42,R43. R44,R45,R46,R47, R48,R49,R50 | 1k | Resistor | RK73H1ETTP1001F | KOA |
| 29 | 1 | R22 | 7.5k 1% | Resistor | RK73H1ETTP7501F | KOA |
| 30 | 10 | R6,R7,R8,R13,R15, R17,R23,R25,R27, R29 | 10k | Resistor | RK73B1ETTP103J | KOA |
| 31 | 1 | R30 | 22k 1% | Resistor | RK73H1ETTP2202F | KOA |
| 32 | 1 | R31 | 39k 1% | Resistor | RK73H1ETTP3902F | KOA |
| 33 | 1 | R35 | 51k 1% | Resistor | RK73H1JTTP5102F | KOA |
| 34 | 2 | R32,R33 | 68k 1% | Resistor | RK73H1ETTP6802F | KOA |
| 35 | 1 | R21 | 82k 1% | Resistor | RK73H1ETTP8202F | KOA |
| 36 | 2 | SW1,SW2 | SW | switch | SKRPABE010 | ALPS ALPINE CO., LTD. |
| M1 | 4 | - | | Screw | B-0206-S1 | Hirosugi |
| M2 | 4 | - | | Spacer | ASB-2010E | Hirosugi |
| M3 | 1 | JP1 | | Jumper socket | XJ8A-0241 | Omron |

Note: This list may be changed without notice.

5.4 Pattern Diagram

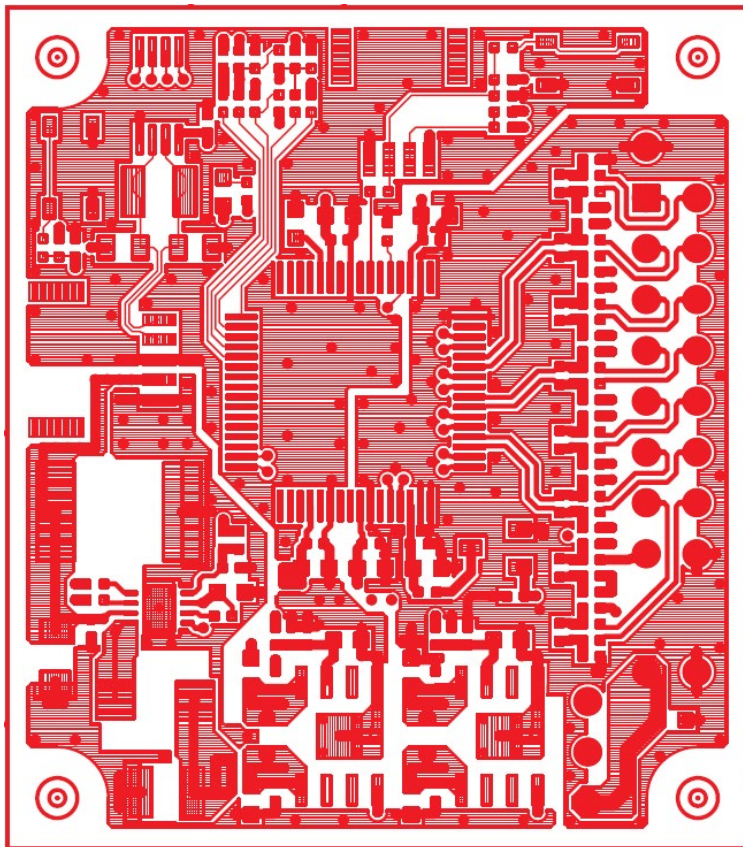


Figure 5-3 Layer 1

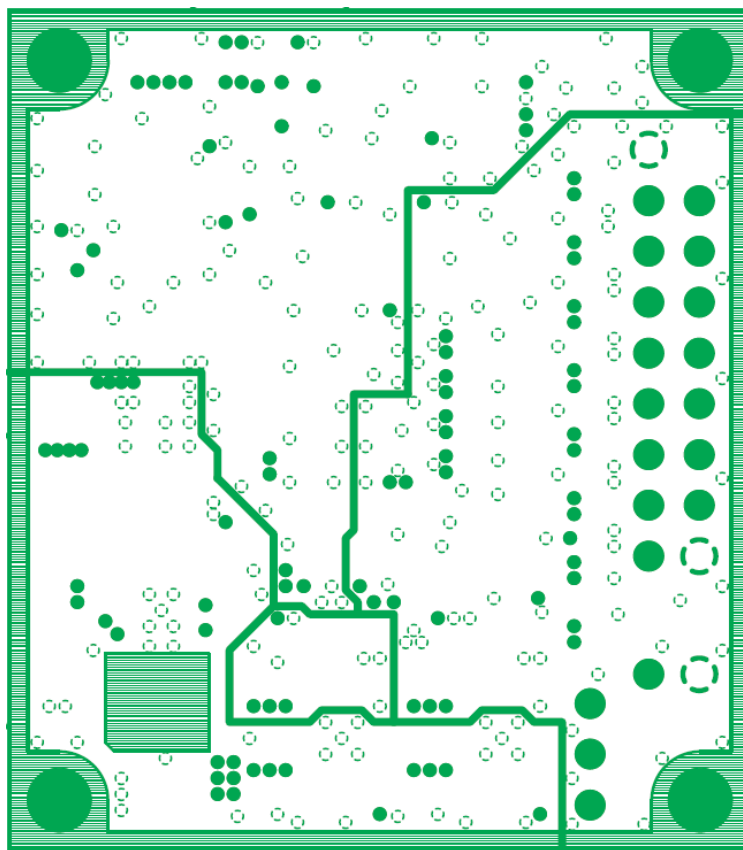


Figure 5-4 Layer 2

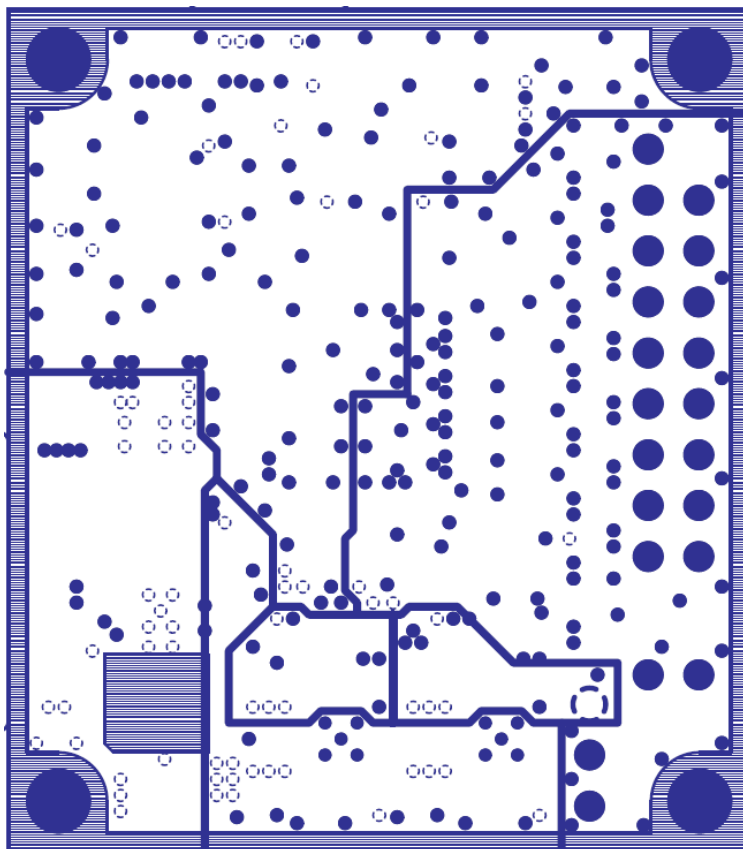


Figure 5-5 Layer 3

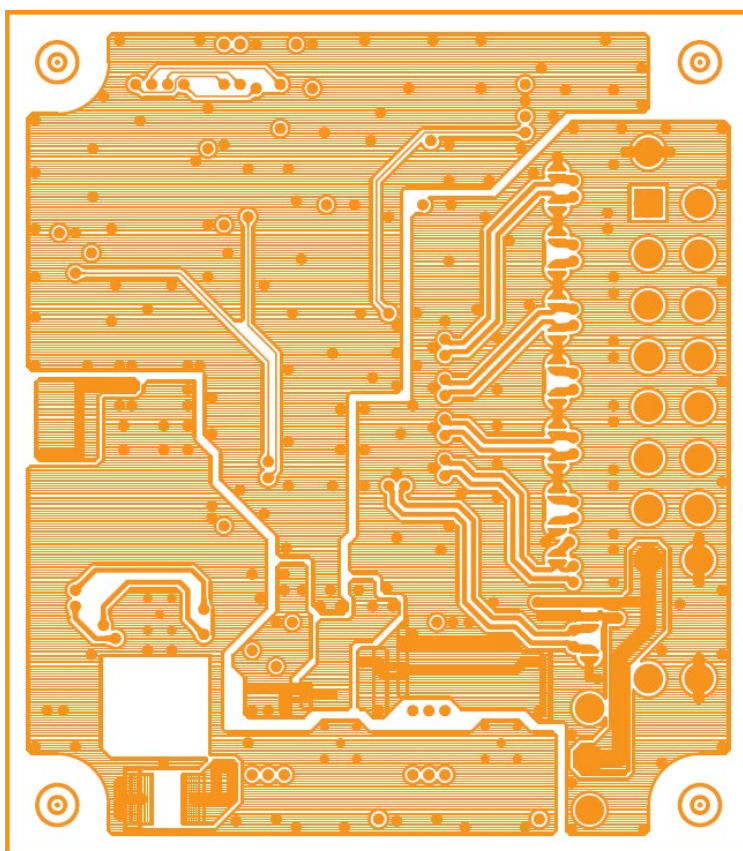


Figure 5-6 Layer 4

6. Force Sensor Measurement

Figure 6-1 shows the connection between the force sensor and the RX23E-B-QFP64-FT.

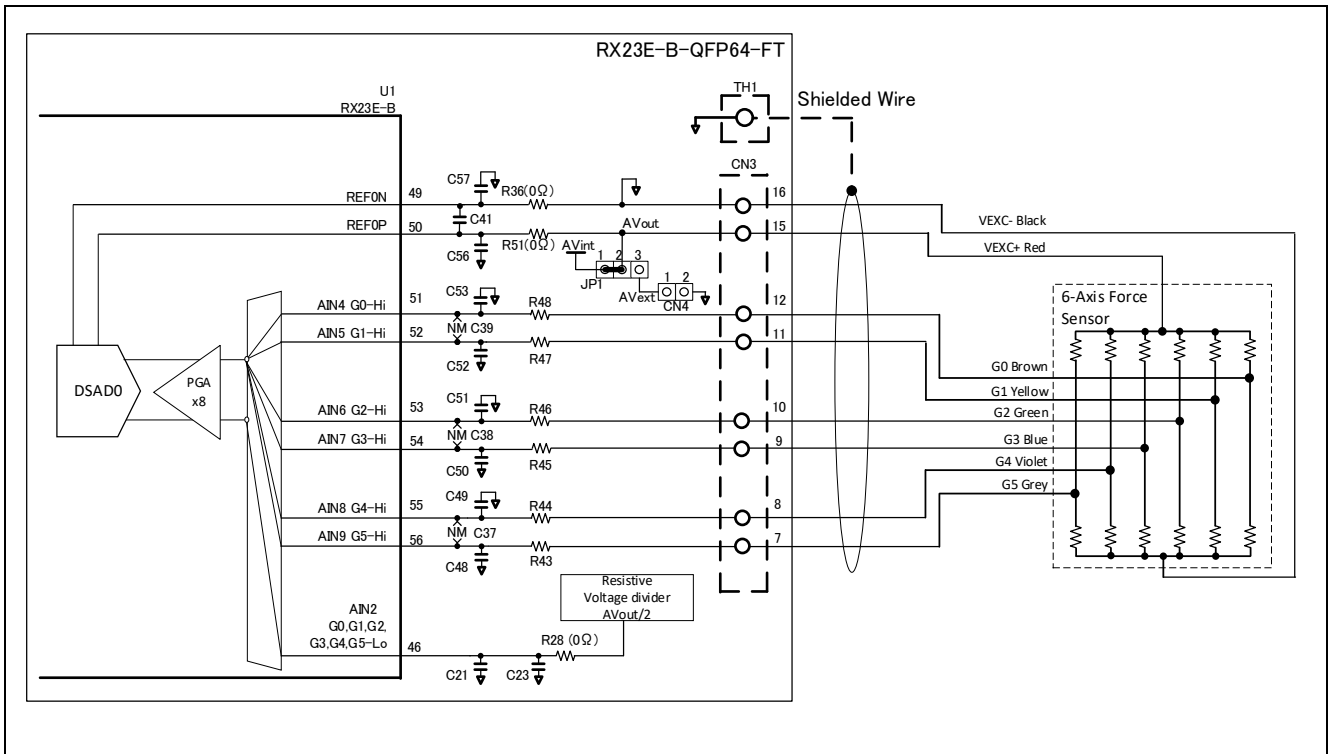


Figure 6-1 Connection of RX23E-B-QFP64-FT and Force Sensor

When a voltage is applied to the excitation voltage terminal of a force sensor, the force sensor outputs the voltage divided by the half-bridge resistors connecting the strain gauges in series in the force sensor. For the voltage AVout applied to the excitation terminal of the force sensor, you can select the power voltage AVint which is generated within the board when connecting the JP1_1-2 pins. When connecting the JP1_2-3 pins, you can select the external power supply voltage AVext which is input from CN4.

The output of the force sensor is connected to AIN4, AIN5, AIN6, AIN7, AIN8, and AIN9 as positive input for DSAD0. The half voltage of AVout is connected to AIN2 as negative input for DSAD0. In measurement, the voltages of AIN4, AIN5, AIN6, AIN7, AIN8, and AIN9 for AIN2 are sequentially A/D converted by using the channel function of the DSAD0, and the force and torque is converted from the A/D conversion results of 6 channels.

6.1 Force Sensor

The strain gauge type 6-axis force sensor is a sensor that utilizes the fact that the resistance value of each strain gauge mounted on the strain body changes due to stress. By applying a voltage to the 6-axis force sensor, the change in resistance value due to stress is measured as a voltage.

If the output voltage of the strain gauge is non-linear in relation to the stress, the characteristic curve is divided into multiple regions, and linear approximation, for example, is performed in each of the regions to increase the measurement precision, thereby matching the characteristic curve. In this example, the region is regarded as a single linear characteristic without being divided.

Supposing that the voltage applied to the strain gauge is V_{CC} , the rated output is RO , and the load rating is S_{max} , the output voltage V for the applied strain S is calculated as below.

$$V = RO \cdot V_{CC} \cdot \frac{S}{S_{max}}$$

Multiply the acquired 6-axis voltage by the force sensor-specified voltage-load conversion matrix C to calculate the force and torque on x, y, and z axis.

$$F = C \times V$$

$$\begin{pmatrix} F_x \\ F_y \\ F_z \\ T_x \\ T_y \\ T_z \end{pmatrix} = \begin{pmatrix} C_{11} & \dots & C_{16} \\ \vdots & \ddots & \vdots \\ C_{61} & \dots & C_{66} \end{pmatrix} \begin{pmatrix} V_0 \\ V_1 \\ V_2 \\ V_3 \\ V_4 \\ V_5 \end{pmatrix}$$

In this example, ATI Industrial Automation 9105-TWE-Gamma is used as a force sensor for measurement. The appearance of the force sensor is shown in Figure 6-2.

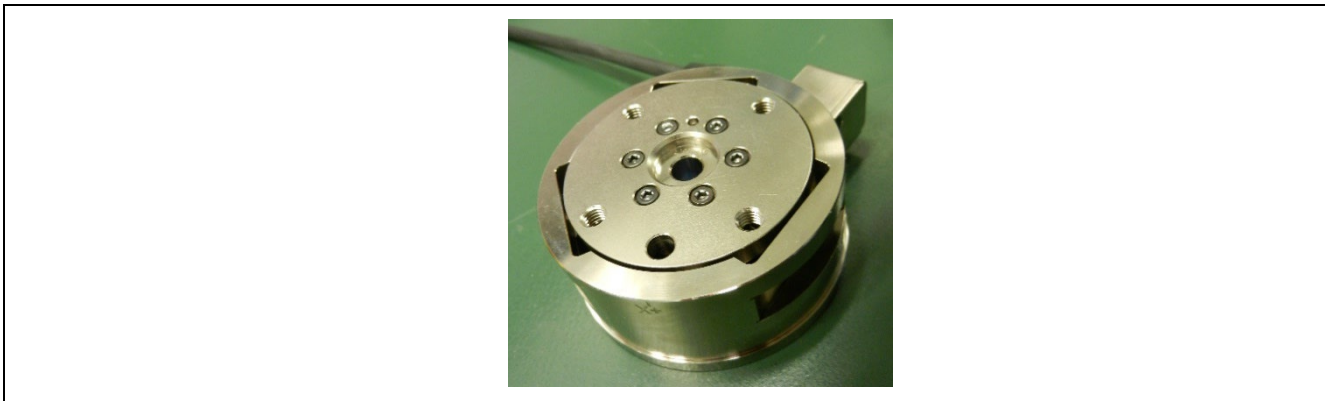


Figure 6-2 Appearance of ATI Industrial Automation 9105-TWE-Gamma

6.2 A/D Conversion of Strain Gauge Output

In this example, the output voltage of each strain gauge is A/D converted with the voltage supplied to each strain gauge as the reference voltage, as shown in Figure 6-1.

Table 6-1 shows the measurement conditions of the force sensor. The digital filter gain is corrected to be 1 by Sinc filter gain correction.

Table 6-1 Force Sensor Measurement Conditions

| Item | Condition | Remarks |
|--------------------------------------|----------------|--|
| PGA gain G_{PGA} | x8 | |
| DSAD0 reference voltage V_{REF} | 5V | Voltage applied to the strain gauge (REF0P=AVOUT, REF0N=AVSS0) |
| Oversampling ratio OSR | 32 | |
| Digital filter gain correction value | 1.0 | $1/G_{DF}$ |
| DSAD0 output format | 2's Complement | |

This example uses the DSAD0 on RX23E-B to scan the output from the 6-axis force sensor. Figure 6-3 shows the conversion sequence, and Table 6-2 shows the A/D conversion time.

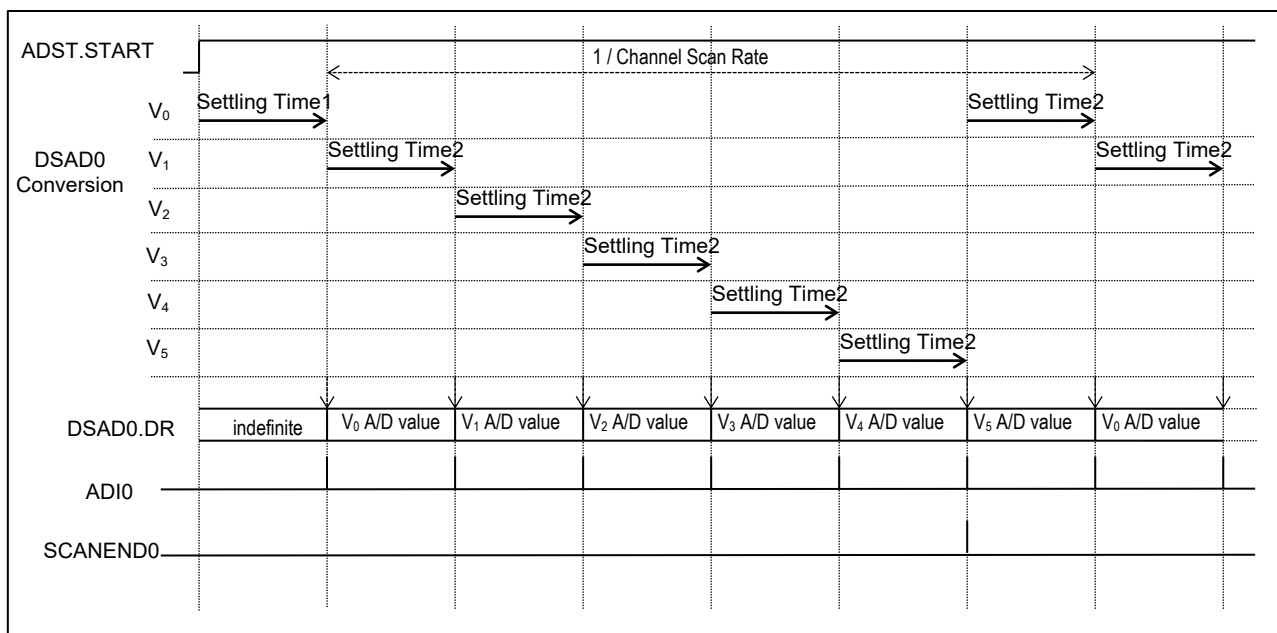


Figure 6-3 A/D Conversion Sequence and A/D Conversion Time

Table 6-2 A/D Conversion Time

$f_{MOD} = 4\text{MHz}$
 $PCLKB=32\text{MHz}$
 Over Sampling Ratio (OSR) = 32
 Sinc Filter (FSEL): Sinc4 + Sinc4

| Item | Value | Remarks |
|-------------------|--------------------|---|
| Settling Time1 | 73.65625 μ s | |
| Settling Time2 | 73.25 μ s | |
| Channel Scan Rate | 2275.312856 scan/s | $= 1 / (\text{Settling Time2} \times 6\text{ch})$ |

6.3 Calculation Procedure

Conversion from the A/D conversion value into the force and torque is performed with the procedure below.

(1) Voltage Calculation

Convert the A/D conversion values outputted from each strain gauge in the force sensor into voltages. Supposing that the PGA gain is G_{PGA} , the reference voltage of the DSAD0 is V_{REF} , and the A/D conversion value is $DATA_n$, output voltage V_n from each strain gauge is calculated from the DSAD0 resolution of 24bit by the equation below.

$$\begin{aligned}
 V_n &= \frac{2V_{REF}}{2^{24} \cdot G_{PGA}} \cdot DATA_n \\
 &= \frac{V_{REF}}{2^{23} \cdot G_{PGA}} \cdot DATA_n, \quad n = 0 \sim 5
 \end{aligned}$$

(2) Force and Torque Conversion

Multiply the acquired 6-axis voltage by the force sensor-specified voltage-load conversion matrix C to calculate the force and torque on x, y, and z axis.

$$F = C \times V$$

$$\begin{pmatrix} F_x \\ F_y \\ F_z \\ T_x \\ T_y \\ T_z \end{pmatrix} = \begin{pmatrix} C_{11} & \dots & C_{16} \\ \vdots & \ddots & \vdots \\ C_{61} & \dots & C_{66} \end{pmatrix} \begin{pmatrix} V_0 \\ V_1 \\ V_2 \\ V_3 \\ V_4 \\ V_5 \end{pmatrix}$$

6.4 Zero-Reset

To correct mechanical offset etc., the A/D conversion value at no load is adjusted to be zero.

In this example, supposing that the offset value is the average of A/D conversion values of individual strain gauge at no load, set the offset value in DSAD0 offset correction register OFCRm so that the offset is canceled.

7. Communication

Communication is conducted as RS-485, half-duplex communication. This program uses QE for AFE or Modbus RTU as the communication protocol. Table 7-1 lists the communication conditions for each communication protocol.

Table 7-1 Communication Conditions

| Item | QE for AFE | Modbus RTU |
|---------------------|---------------|-------------|
| Communication speed | 4,000,000 bps | 115,200 bps |
| Data length | 8 bits | |
| Start bit | 1 bit | |
| Parity | None | Even parity |
| Stop bit | 1 bit | |

7.1 QE for AFE

For details about the QE for AFE communication module, refer to the Application Note "RX23E-B Group RSSKRX23E-B Board Control Program".

Note: Since QE for AFE is based on full-duplex communication, transmission and reception may conflict and stop on an instruction of measurement stop.

7.2 Modbus RTU

Operation setting and measurement result acquisition are performed with Modbus RTU communication. For details about Modbus RTU, refer to the Modbus official site (<https://modbus.org/specs.php>).

In this example, communication is conducted under the conditions listed in Table 7-2.

Table 7-2 Modbus RTU Communication Conditions

| Item | Condition |
|--------------------------------|---|
| Slave address | H'01 |
| Silent interval | (3.5 bytes or more) |
| Maximum receive byte interval | (3 byte) |
| Maximum transmit byte interval | (2 byte) |
| Response time | 1ms or less |
| Maximum frame length | 256 byte |
| Supported Query functions | H'01: Read Coil H'02: Read Status H'03: Read Holding Register H'04: Read Input Register H'05: Write Single Coil H'06: Write Single Holding Register H'10: Write Multiple Holding Register |
| Supported Exception codes | H'01: Illegal function H'02: Illegal data address H'03: Illegal data H'04: Device Failure H'05: Acknowledge H'06: Device Busy |

7.2.1 Supported Frame Format

The message frame format is shown in Table 7-3. The function codes used in this example and the data format for each function are listed in Table 7-4, and the storage order for data of single precision floating point type is shown in Table 7-5.

Table 7-3 Message Frame for Modbus RTU

| Address | Function | Data | CRC |
|---------|----------|--------|---------|
| 1 byte | 1 byte | N byte | 2 bytes |

Table 7-4 Supported Function Code and Description of Data

| Supported Function Code | Type | Bytes of Data | Data | | | | | | | | | |
|--|----------|-------------------------|--|-------|---------------------|-------|------------|-------|-------|-----------------------|--------------|--|
| | | | +0 | +1 | +2 | +3 | +4 | +5 | +6 | +2m-1 +2k+3 | +2m +2k+4 | |
| Read Coil (H'01) Read Input Status (H'02) | query | 4 | Start Address | | Num of read (M) | | | | | | | |
| | | | Upper | Lower | Upper | Lower | | | | | | |
| | response | 1+ Round up of (M/8) | Data bytes | Data1 | Data2 | | | | | Data (roundup of M/8) | | |
| Read Holding Register (H'03) Read Input Register (H'04) | query | 4 | Start Address | | Num of read (m) | | | | | | | |
| | | | Upper | Lower | Upper | Lower | | | | | | |
| | response | 1+2m | Data bytes | Data1 | | | | | | Data m | | |
| | | | Upper | Lower | | | | | Upper | Lower | | |
| Write Single Coil (H'05) Write Single Holding Register (H'06) | query | 4 | Address | | Data | | | | | | | |
| | | | Upper | Lower | Upper | Lower | | | | | | |
| | response | 4 | Address | | Data | | | | | | | |
| | | | Upper | Upper | Upper | Lower | | | | | | |
| Write Multiple Holding Registers (H'10) | query | 5+2k | Start Address | | Num of Register (k) | | Data bytes | data1 | | data k | | |
| | | | Upper | Lower | Upper | Lower | | Upper | Lower | Upper | Lower | |
| | response | 4 | Start Address | | Num of Register (m) | | | | | | | |
| | | | Upper | Lower | Upper | Lower | | | | | | |
| exception | response | 1 | Exception Code H'01: Illegal function H'02: Illegal data address H'03: Illegal data H'04: Device Failure H'05: Acknowledge H'06: Device Busy | | | | | | | | | |

Table 7-5 Single Precision Floating Data Format

| bit | 31 | 30 | 24 | 23 | 22 | 16 | 15 | 8 | 7 | 0 |
|------------|-------------|----------|----|------------|----------|----|-------------|---|------------|---|
| Allocation | sign | exponent | | | fraction | | | | | |
| | Upper byte | | | Lower byte | | | Upper byte | | Lower byte | |
| | Upper 16bit | | | | | | Lower 16bit | | | |

7.2.2 Data

The data used in this example and their arrangement are shown in Table 7-6 and Table 7-7.

Table 7-6 Data List (1/2)

| Function | Address | size | Format | Name | description |
|----------------|---------|-------|--------|---------------|---|
| Coil | 0 | 2byte | uint16 | Measurement | Force sensor measurement H'0000: Off (default) H'0001: On |
| | 1 | | | Zero reset | Zero reset H'0000: Stop (default) H'0001: Start |
| Input Status | 0 | 2byte | uint16 | CH0 OVF | CH0 Error/Overflow flag at DSAD0 operation |
| | 1 | | | CH0 ERR | |
| | 2 | | | CH1 OVF | CH1 Error/Overflow flag at DSAD0 operation |
| | 3 | | | CH1 ERR | |
| | 4 | | | CH2 OVF | CH2 Error/Overflow flag at DSAD0 operation |
| | 5 | | | CH2 ERR | |
| | 6 | | | CH3 OVF | CH3 Error/Overflow flag at DSAD0 operation |
| | 7 | | | CH3 ERR | |
| | 8 | | | CH4 OVF | CH4 Error/Overflow flag at DSAD0 operation |
| | 9 | | | CH4 ERR | |
| | 10 | | | CH5 OVF | CH5 Error/Overflow flag at DSAD0 operation |
| | 11 | | | CH5 ERR | |
| Input Register | 0 | 4byte | float | Fx | Force on x-axis |
| | 2 | 4byte | float | Fy | Force on y-axis |
| | 4 | 4byte | float | Fz | Force on z-axis |
| | 6 | 4byte | float | Tx | Torque on x-axis |
| | 8 | 4byte | float | Ty | Torque on y-axis |
| | 10 | 4byte | float | Tz | Torque on z-axis |
| | 12 | 4byte | int32 | CH0 A/D Value | CH0 A/D value at DSAD0 operation |
| | 14 | 4byte | int32 | CH1 A/D Value | CH1 A/D value at DSAD0 operation |
| | 16 | 4byte | int32 | CH2 A/D Value | CH2 A/D value at DSAD0 operation |
| | 18 | 4byte | int32 | CH3 A/D Value | CH3 A/D value at DSAD0 operation |
| | 20 | 4byte | int32 | CH4 A/D Value | CH4 A/D value at DSAD0 operation |
| | 22 | 4byte | int32 | CH5 A/D Value | CH5 A/D value at DSAD0 operation |

Table 7-7 Data List (2/2)

| Function | Address | size | Format | Name | description |
|------------------|---------|--------|----------------|--|--------------------------------|
| Holding Register | 0 | 4byte | float | C11 | Voltage-load conversion matrix |
| | 2 | 4byte | float | C12 | |
| | 4 | 4byte | float | C13 | |
| | 6 | 4byte | float | C14 | |
| | 8 | 4byte | float | C15 | |
| | 10 | 4byte | float | C16 | |
| | 12 | 4byte | float | C21 | |
| | 14 | 4byte | float | C22 | |
| | 16 | 4byte | float | C23 | |
| | 18 | 4byte | float | C24 | |
| | 20 | 4byte | float | C25 | |
| | 22 | 4byte | float | C26 | |
| | 24 | 4byte | float | C31 | |
| | 26 | 4byte | float | C32 | |
| | 28 | 4byte | float | C33 | |
| | 30 | 4byte | float | C34 | |
| | 32 | 4byte | float | C35 | |
| | 34 | 4byte | float | C36 | |
| | 36 | 4byte | float | C41 | |
| | 38 | 4byte | float | C42 | |
| | 40 | 4byte | float | C43 | |
| | 42 | 4byte | float | C44 | |
| | 44 | 4byte | float | C45 | |
| | 46 | 4byte | float | C46 | |
| | 48 | 4byte | float | C51 | |
| | 50 | 4byte | float | C52 | |
| | 52 | 4byte | float | C53 | |
| | 54 | 4byte | float | C54 | |
| | 56 | 4byte | float | C55 | |
| | 58 | 4byte | float | C56 | |
| | 60 | 4byte | float | C61 | |
| | 62 | 4byte | float | C62 | |
| | 64 | 4byte | float | C63 | |
| | 66 | 4byte | float | C64 | |
| 68 | 4byte | float | C65 | | |
| 70 | 4byte | float | C66 | | |
| 72 | 4byte | int32 | OFCR0 | Offset correction value for each CH of DSAD0 | |
| 74 | 4byte | int32 | OFCR1 | | |
| 76 | 4byte | int32 | OFCR2 | | |
| 78 | 4byte | int32 | OFCR3 | | |
| 80 | 4byte | int32 | OFCR4 | | |
| 82 | 4byte | int32 | OFCR5 | | |
| 84 | 2byte | uint16 | Num of Average | Averaging count for zero reset | |

7.2.3 Operation

Operation via Modbus equivalent to operation on QE for AFE in "Table 1-1 Operable Items" is shown in Table 7-8.

Table 7-8 Items Operable via Modbus

| Item | Operation | Remarks |
|---|--|--|
| Measurement start and stop | Operate Coil:0 | LED1 is OFF during measurement |
| Zero reset | Set Coil:1 | Enabled only during standby (LED1 is ON) |
| Specifying the averaging count for zero reset | Set 64 to 512 in HoldingReg:11, default: 128 | |
| Parameter initialization | Set Coil:2 | |

8. Sample Program

8.1 Overview of Operation

Figure 8-1 shows the process flow of this sample program.

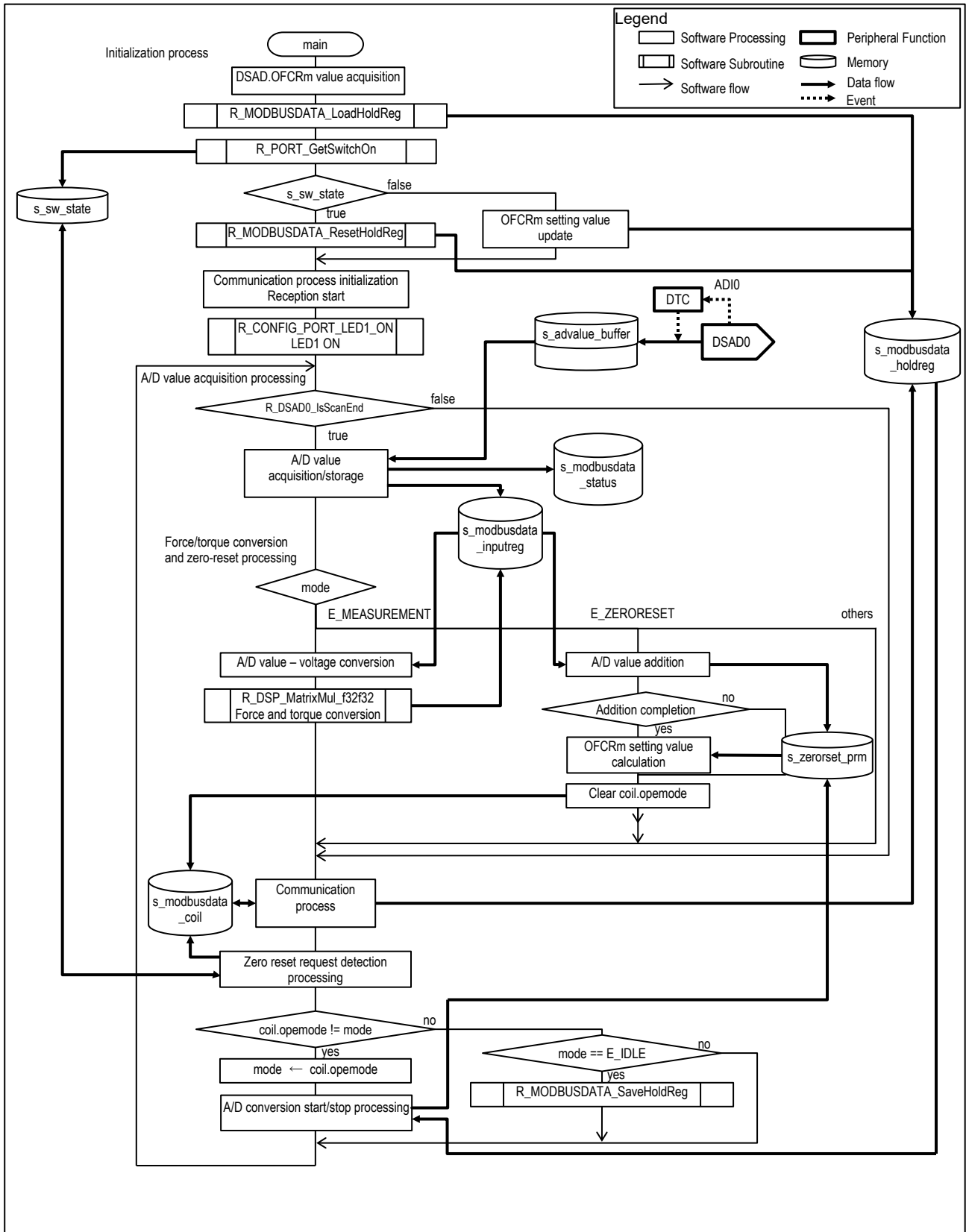


Figure 8-1 Force Sensor Measurement Process Flow

This program works based on ModbusData. The operating mode is specified with the Coil member `ope_mode`. Operating modes are listed in Table 8-1.

Table 8-1 Operating Modes

| Name | ope_mode | Description |
|---------------|----------|-------------|
| E_IDLE | 0 | Standby |
| E_MEASUREMENT | 1 | Measurement |
| E_ZERORESET | 2 | Zero reset |

The following provides an overview of each of the processes in Figure 8-1

- Initialization process
 - Loads the parameters stored in E2 data flash into the Holding register in ModbusData.
 - When SW1 is pressed, initializes the DSAD0 offset correction value and the averaging count for zero reset in the Holding register.
 - Initializes the communication process and starts reception.
 - Turns LED1 on.
- A/D value acquisition processing

With the end of the A/D conversion (ADI0) as a trigger, transmits the A/D conversion result to the A/D conversion result storage array by DTC. The A/D conversion result storage array is 6 x 2, and the plane which is not the target of DTC transfer is to be processed.

When the end of DSAD0 channel scan (SCANEND0) is detected, stores the A/D value in the Input register in ModbusData and the error information on A/D conversion in the Status in ModbusData from the acquired A/D conversion result of 6 channels.
- Force and torque conversion and zero-reset processing

Processes the acquired A/D value according to the operating mode in A/D conversion start/stop processing.

 - opemode: E_MEASUREMENT

According to "6.3 Calculation Procedure", converts the A/D values into voltage values and multiplies them by voltage-load conversion matrix to calculate the force and torque. Stores the calculation results in the Input register in ModbusData.
 - opemode: E_ZERORESET

According to "6.4 Zero Reset", stores the average of the A/D values of each channel in the Holding register in ModbusData as offset correction values. The averaging count is based on the Holding register member average.
- Communication process

Processes a request from the Host and sets transmission of a response. For the QE for AFE version, transmits the measurement result of the force and torque as well. For details, refer to "8.3 Communication Control".
- Zero reset request detection processing

On detection of pressing of SW1, if the operating mode is E_IDLE, sets E_ZERORESET in the Coil member `ope_mode` in ModbusData.

- A/D conversion start/stop processing
If the Coil member `ope_mode` in ModbusData is changed, the followings are processed based on the new `ope_mode`.
 - `ope_mode`: E_MEASUREMENT
 - Sets the DSAD0 offset correction value in the ModbusData Holding register in the register OFCRm.
 - Sets starting of DTC transfer of the A/D conversion result.
 - Starts A/D conversion.
 - Turns LED1 off.
 - `ope_mode`: E_ZERORESET
 - Sets 0 in the register OFCRm.
 - Initializes the zero-reset parameter.
 - Set starting of DTC transfer of the A/D conversion result.
 - Starts A/D conversion.
 - Turns LED1 off.
 - `ope_mode`: E_IDLE
 - Stops A/D conversion.
 - Sets stopping of DTC transfer of the A/D conversion result.
 - Turns LED1 on.
- E2 data flash storage processing
If the Coil member `ope_mode` in ModbusData does not change from E_IDLE, and there is a change in the retention parameter in the Holding register in ModbusData, stores it in E2 data flash.

8.2 Functions and Settings of MCU Used

Table 8-2 lists the peripheral functions used in this example, and Table 8-3 lists the pins used. Also, Table 8-4 shows the clock settings. Unused pins are set to output Low.

The settings for the peripheral functions are generated by using the code generation function of Smart Configurator. The following shows the peripheral function settings.

Table 8-2 Peripheral Functions

| Peripheral function | Use | |
|---------------------|---|--|
| | QE for AFE version | Modbus version |
| DSAD0 | A/D conversion of force sensor output | |
| SCI1 | Communication with QE for AFE | Communication with Modbus host |
| DMAC0 | Reception of packets from QE for AFE | - |
| DMAC1 | Transmission of packets to QE for AFE | |
| TMR0 | - | Communication with Modbus host |
| DTC | Acquisition of A/D conversion result | Acquisition of A/D conversion result Communication with Modbus host |
| CRC | - | Communication with Modbus host |
| PC3 | LED1 ON/OFF control | |
| PC4 | Detection of SW1 state | |
| P31 | Setting RS-485 driver transmission or reception | |
| E2DataFlash | Saving retention parameters | |

Table 8-3 Pins

| Pin name | I/O | Use |
|----------|-----|--|
| AIN2 | I | Negative input signal for sensor output |
| AIN4 | I | Positive input signal for sensor output 1 |
| AIN5 | I | Positive input signal for sensor output 2 |
| AIN6 | I | Positive input signal for sensor output 3 |
| AIN7 | I | Positive input signal for sensor output 4 |
| AIN8 | I | Positive input signal for sensor output 5 |
| AIN9 | I | Positive input signal for sensor output 6 |
| REF0P | I | DSAD0 positive side reference voltage |
| REF0N | I | DSAD0 negative side reference voltage |
| P26/TXD1 | O | UART1 transmission pin |
| P30/RXD1 | I | UART1 reception pin |
| P31 | O | RS-485 driver transmission/reception switching control pin |
| PC3 | O | LED1 ON/OFF control pin |
| PC4 | I | SW1 input pin |

Table 8-4 Clock Settings

| Item | Setting |
|---------------|---|
| Clock used | HOCO clock (32MHz) Enable HOCO oscillation after reset |
| SCKCR (FCLK) | x1 (32MHz) |
| SCKCR (ICLK) | x1 (32MHz) |
| SCKCR (PCLKA) | x1 (32MHz) |
| SCKCR (PCLKB) | x1 (32MHz) |
| SCKCR (PCLKC) | x1 (32MHz) |
| SCKCR (PCLKD) | x1 (32MHz) |

8.2.1 Force Sensor Measurement

DSAD0 is used for A/D conversion of the force sensor output, and DTC is used to acquire the A/D conversion result. Table 8-5 and Table 8-6 show the settings of AFE and DSAD0 based on the measurement conditions in Table 6-1, and Table 8-7 shows the settings of DTC.

Table 8-5 DSAD0 Settings

Continuous scan mode

| Item | | Setting | | | | | |
|---|--|-------------------------------------|------|------|------|------|------|
| Operation clock setting | | PCLK/2(16MHz) | | | | | |
| Conversion start trigger source | | Software trigger | | | | | |
| Interrupt setting | Enable $\Delta\Sigma$ /D conversion completion interrupt (ADI0) | Enable, Priority: Level 0(disabled) | | | | | |
| | Enable $\Delta\Sigma$ /D conversion scan completion interrupt (SCANEND0) | Enable, Priority: Level 0(disabled) | | | | | |
| | Enable $\Delta\Sigma$ /D channel change interrupt (CHCHG0) | Disable | | | | | |
| Voltage fault and disconnection setting | | Not used | | | | | |
| Analog input channel setting | | 0 | 1 | 2 | 3 | 4 | 5 |
| Analog input setting | Positive input signal | AIN4 | AIN5 | AIN6 | AIN7 | AIN8 | AIN9 |
| | Negative input signal | AIN2 | | | | | |
| | Reference input | REF0P/REF0N | | | | | |
| | Positive reference voltage buffer | Disable | | | | | |
| | Negative reference voltage buffer | Disable | | | | | |
| Amplifier setting | Amplifier selection | PGA | | | | | |
| | PGA gain setting | x8 | | | | | |
| $\Delta\Sigma$ /D conversion setting | A/D conversion mode | Normal operation | | | | | |
| | Data format | Two's complement | | | | | |
| | A/D conversion number | 1 | | | | | |
| | First stage oversampling ratio | 32 | | | | | |
| | Second stage oversampling ratio | Not used | | | | | |
| | Set offset calibration value | Not used | | | | | |
| Disconnect detection assist setting | | Disable | | | | | |
| Digital filter setting | Sinc filter select | Sinc4 + Sinc4 | | | | | |
| | Set sinc filter gain calibration | Used | | | | | |
| | Sinc filter gain calibration value | 1 | | | | | |

Table 8-6 AFE Settings

| Item | | Setting |
|-------------------------------------|----------------------------|---------|
| Bias output setting | Enable bias voltage output | Enable |
| | AIN2 output pin | Disable |
| | AIN10 output pin | Disable |
| Excitation current output setting | | Disable |
| Low level voltage detection setting | | Disable |
| Low-side switch control setting | | Disable |

Table 8-7 DTC Settings (Config_DTC_DSAD0)

| Item | | Setting |
|------------------------------------|-------------------------|---|
| Base setting | Transfer data read skip | Enable |
| | Address mode | Short-address mode (24 bits) |
| | DTC vector base address | 0x00007C00 (default value) |
| Activation source setting | Activation source | DSAD0 (ADI0) |
| | Chain transfer | Not used |
| Transfer mode setting | | Repeat mode |
| Transfer data size setting | | 32bit |
| Interrupt setting | | An interrupt request to the CPU is disabled when specified data transfer is completed |
| Block / Repeat area setting | | Transfer destination |
| Transfer address and count setting | Source address | 0x000A1070 (DSAD0.DR) Address fixed |
| | Destination address | (Set by the program) Address incremented |
| | Count | 12 |

8.2.2 Communication

To communicate with QE for AFE or the Modbus host, SCI1 is used for transmission/reception in the asynchronous mode. To switch RS-485 driver between transmission and reception, P31 is used.

For QE for AFE version, DMAC0 is used to acquire received data, and DMAC3 is used to transmit data.

For Modbus version, DTC is used to acquire received data and transmit data, and TMR0 is used to detect frame reception and the end of frame transmission.

The following shows the setting conditions for each peripheral function.

Table 8-8 SCI1 Settings

Asynchronous mode

Operation mode: Transmission/reception

| Item | Setting | | |
|----------------------------------|---|----------------------|---------------------|
| | For QE for AFE | | For Modbus |
| Start bit edge detection setting | Falling edge on RXD1 pin | | |
| Data length setting | 8 bits | | |
| Parity setting | None | Even | |
| Stop bit length setting | 1 bit | | |
| Transfer direction setting | LSB-first | | |
| Transfer rate setting | Transfer clock | Internal clock | |
| | Bit rate | 4,000,000bps | 115,200bps |
| | Enable modulation duty correction | Not used | Used |
| | SCK1 pin function | SCK1 is not used | |
| Noise filter setting | Not used | | |
| Hardware flow control setting | None | | |
| Data handling setting | Transfer data handling | Data handled by DMAC | Data handled by DTC |
| | Receive data handling | Data handled by DMAC | Data handled by DTC |
| Interrupt setting | Enable reception error interrupt (ERI1) | Not used | |
| | TXI1, RXI1, TEI1, ERI1 priority | Level 1 | |
| Callback function setting | Not used | | |

Table 8-9 P31 Setting

| Item | Setting |
|----------------|--------------------|
| Port selection | PORT3 |
| Used port | P31 |
| Setting | Out CMOS output |

Table 8-10 DMAC Settings (for QE for AFE)

| Item | | Setting | |
|-----------------------------|--|---|---|
| | | DMAC0 | DMAC1 |
| Transfer setting | Activation source | SCI1 (RXI1) | SCI1 (TXI1) |
| | Activation source flag control | Clear interrupt flag of the activation source | |
| | Transfer mode | Free running mode | Normal mode |
| | Transfer data size | 8 bits | |
| | Transfer count / Repeat size / Block size | - | (Setting on execution) |
| Source address setting | Source address | 0x0008A025 (SCI1.RDR) Fixed | (Setting on execution) Incremented |
| | Specify the transfer source as extended repeat area | - | Enable |
| | Extended repeat area | | Lower 9 bits of the address (512 bytes) |
| Destination address setting | Destination address | (Set by the program) Incremented | 0x0008A023(SCI1.TDR) Fixed |
| | Specify the transfer destination as extended repeat area | Enable | - |
| | Extended repeat area | Lower 9 bits of the address (512 bytes) | |
| Interrupt setting | | Not used | |

Table 8-11 TMR0 Settings (for Modbus)

| Item | | Setting |
|---------------------|--|------------------|
| Count setting | Clock source | PCLK/64 (500kHz) |
| | Counter clear | Disabled |
| | Compare match A value (TCORA) | 334μs |
| | Compare match B value (TCORB) | 238μs |
| TMO0 output setting | | Not used |
| Interrupt setting | Enable TCORA compare match interrupt (CMIA0) | Enabled |
| | Enable TCORB compare match interrupt (CMIB0) | Enabled |
| | Enable TCNT overflow interrupt (OVI0) | Disabled |
| | Priority | Level 1 |

Table 8-12 DTC Settings: Config_DTC_RXI1 (for Modbus)

| Item | | Setting | | |
|------------------------------------|-------------------------|---|---|---|
| | | DTC0 | DTC1 | DTC2 |
| Basic setting | Transfer data read skip | Enable | | |
| | Address mode | Short-address mode (24 bits) | | |
| | DTC vector base address | 0x00007C00 (default value) | | |
| Activation source setting | Activation source | SCI1 (RXI1) | - | - |
| | Chain transfer | Used | | Not used |
| Chain transfer setting | | Continuous | | - |
| Transfer mode setting | | Repeat mode | | |
| Transfer data size setting | | 8 bits | 8 bits | 8 bits |
| Interrupt setting | | An interrupt request to the CPU is disabled when specified data transfer is completed | | |
| Block / Repeat area setting | | Transfer destination | | |
| Transfer address and count setting | Source address | 0x0008A025 (SCI1.RDR) Address fixed | (Set by the program) Address fixed | |
| | Destination address | (Set by the program) Address incremented | 0x00088208 (TMR0.TCNT) Address fixed | 0x00088208 (TMR0.TCNT) Address fixed |
| | Count | 256 | 1 | 1 |

Table 8-13 DTC Settings: Config_DTC_TXI1 (for Modbus)

| Item | | Setting |
|------------------------------------|-------------------------|--|
| Basic setting | Transfer data read skip | Enable |
| | Address mode | Short-address mode (24 bits) |
| | DTC vector base address | 0x00007C00 (default value) |
| Activation source setting | Activation source | SCI1 (TXI1) |
| | Chain transfer | Not used |
| Transfer mode setting | | Normal mode |
| Transfer data size setting | | 8 bits |
| Interrupt setting | | An interrupt request to the CPU is generated when specified data transfer is completed |
| Transfer address and count setting | Source address | (Set by the program) Address incremented |
| | Destination address | 0x0008A023(SCI1.TDR) Address fixed |
| | Count | (Setting on execution) |

Table 8-14 DTC Settings: Config_DTC_CMIA0 (for Modbus)

| Item | | Setting | | | |
|------------------------------------|-------------------------|---|---------------------------------------|---------|---|
| | | DTC0 | DTC1 | DTC2 | DTC3 |
| Basic setting | Transfer data read skip | Enable | | | |
| | Address mode | Short-address mode (24 bits) | | | |
| | DTC vector base address | 0x00007C00 (default value) | | | |
| Activation source setting | Activation source | TMR0(CMIA0) | - | - | - |
| | Chain transfer | Used | | | Not used |
| Chain transfer setting | | Continuous | | | - |
| Transfer mode setting | | Repeat mode | | | |
| Transfer data size setting | | 8 bits | 8 bits | 16 bits | 16 bits |
| Interrupt setting | | An interrupt request to the CPU is disabled when specified data transfer is completed | | | An interrupt request to the CPU is generated each time DTC data transfer is performed |
| Block / Repeat area setting | | Transfer destination | | | |
| Transfer address and count setting | Source address | (Set by the program) Address fixed | | | |
| | Destination address | 0x0008820A (TMR0.TCCR) Address fixed | (Set by the program) Address fixed | | |
| | Count | 1 | 1 | 1 | 1 |

Table 8-15 CRC Settings (for Modbus)

| Item | Setting | |
|---------------------|-----------------------------------|----------|
| Calculation setting | Generating polynomial | CRC_16 |
| | Bit order | LSB |
| | Initial value | 0xFFFF |
| | Invert result of calculated value | Not used |

8.2.3 LED1 and SW1

PC3 is used to turn LED1 on and off. PC4 is used to get the state of SW1.

Table 8-16 shows the settings for each port.

Table 8-16 PORTC Settings

| Item | Setting | |
|----------------|--------------------------------|-----|
| Port selection | PORTC | |
| Used port | PC3 | PC4 |
| Setting | Out CMOS output Output 1 | In |

8.2.4 E2 Data Flash

E2 Data Flash is used to retain the setting parameters. To access E2 Data Flash, the FIT flash module is used.

Table 8-17 FIT Flash Module Settings

| Item | Setting |
|--|--|
| Parameter check | Enable parameter checks |
| Enable code flash programming | Only data flash |
| Enable BGO/Non-blocking data flash operation | Forces data flash API function to block until completed. |
| Enable BGO/Non-blocking code flash operation | Forces ROM API function to block until completed. |
| Enable code flash self-programming | Programming code flash while executing in RAM. |

8.3 Communication Control

8.3.1 QE for AFE Communication

QE for AFE communication uses the communication module included in the "RX23E-B Group RSSKRX23E-B Board Control Program". For details, refer to the Application Note.

The QE for AFE communication process flow in this example is shown in Figure 8-2. Measured value packet setting is performed based on flag_update which is set in Force/torque conversion processing.

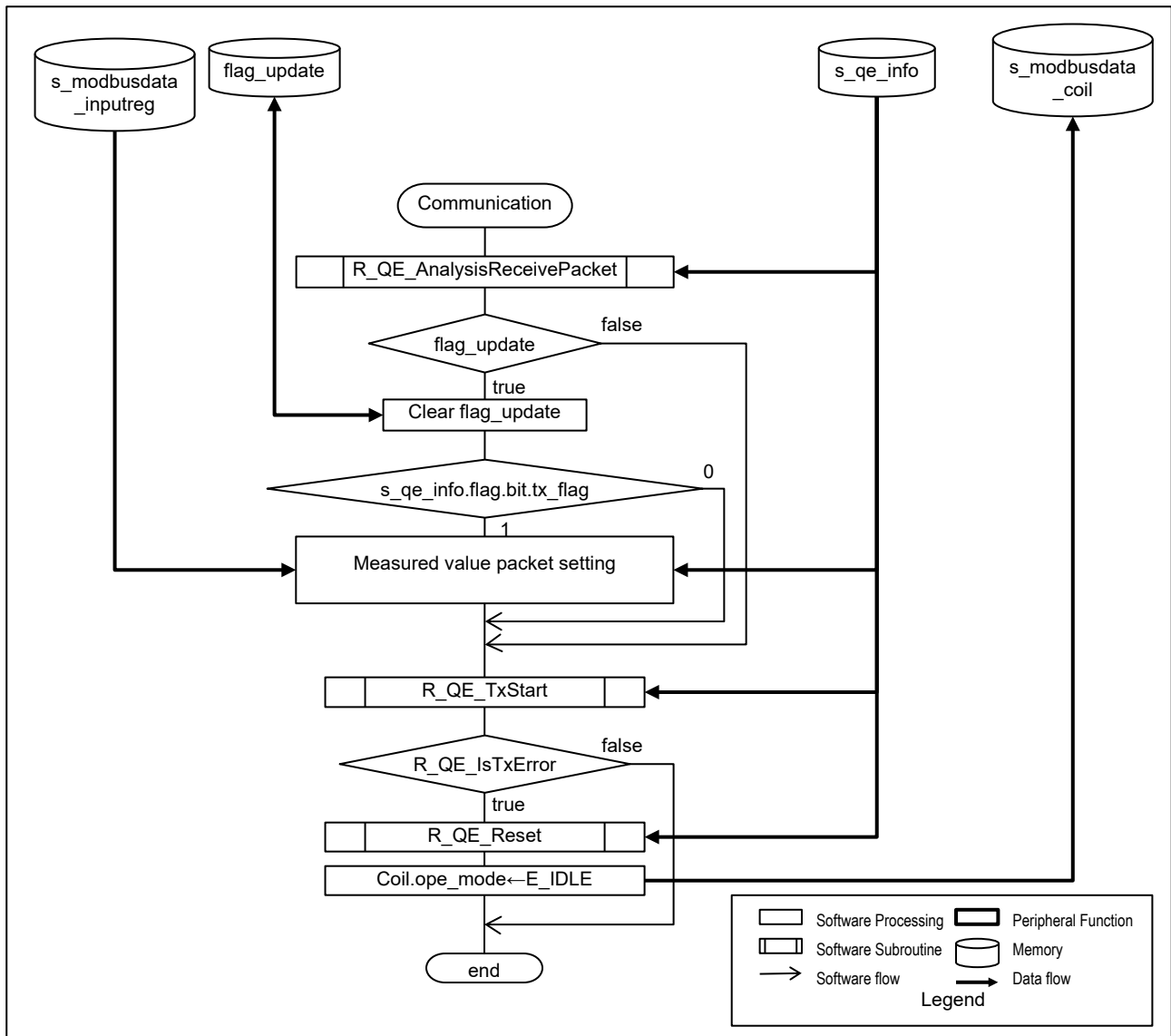


Figure 8-2 QE for AFE Communication Process Flow

8.3.2 Modbus RTU Communication

This sample program conducts data transmission/reception with DTC transfer, and the designated wait time indicating the end of communication is set with the timer TMR0.

Reception processing is handled only by DTC and TMR0, and the CPU is not involved.

Transmission processing sets transmit data in SCI1 with DTC, detects completion of data transmission with the TEI of SCI1, and waits for the transmit end with TMR0. Transmit end processing is performed with the compare match interrupt CMIB0 of TMR0.

The program detects reception with the compare match interrupt request CMIA0 of TMR0, creates the response frame for the received Modbus frame, and makes transmission settings.

8.3.2.1 Transmit/Receive Processing

A communication timing chart is shown in Figure 8-3, and the communication process flow is shown in Figure 8-4.

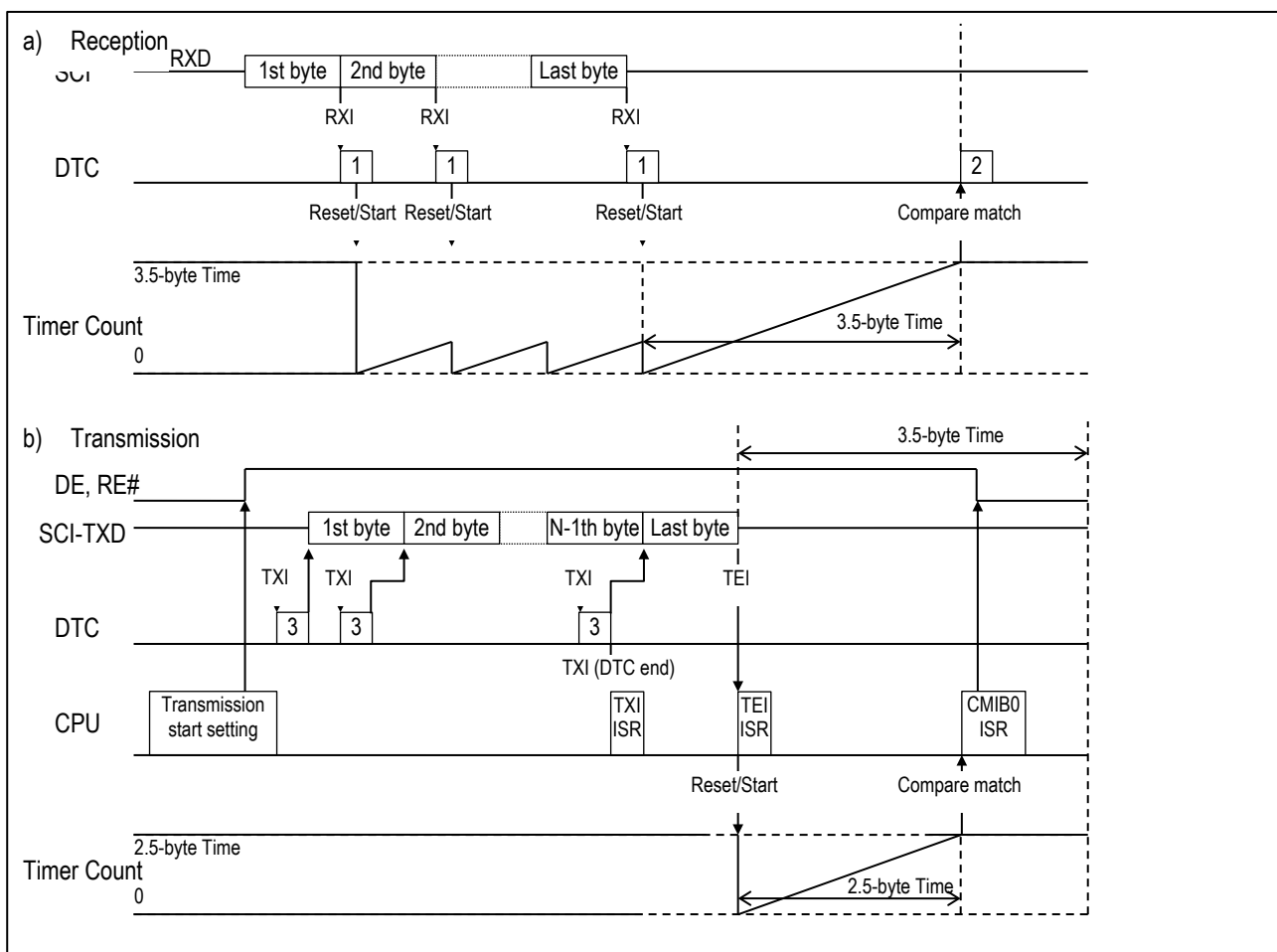


Figure 8-3 Modbus Communication Timing Chart

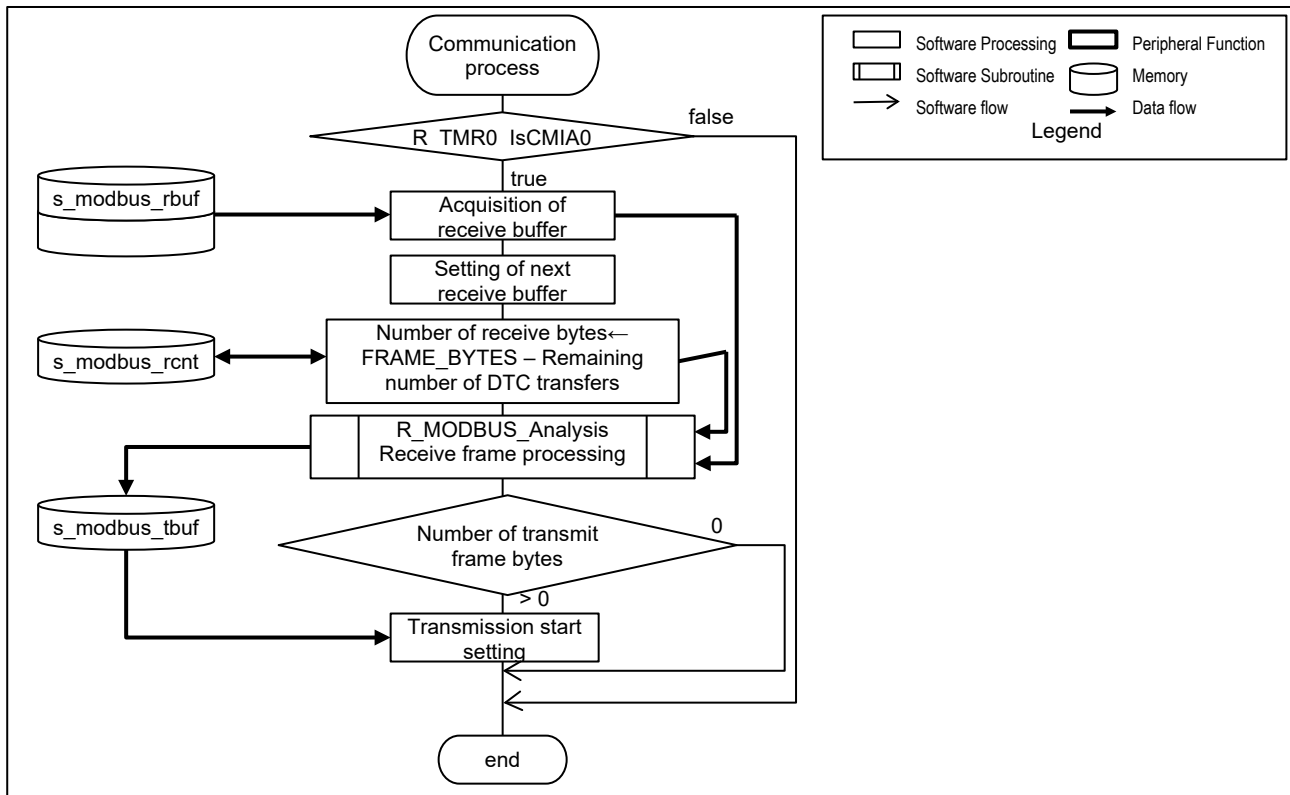


Figure 8-4 Modbus Communication Process Flow

Receive processing and transmit processing are performed as described below.

- Receive processing

- (1) At the RXI1 interrupt request for every 1-byte reception, DTC transfer 1 (DTC_RXI1) performs the following:

- Transfer the receive data to the receive buffer on memory
- Reset and restart TMR0

- (2) On TMR0 compare match A interrupt request (CMIA0), DTC transfer 2 (DTC_CMIA0) performs the following:

- Stop the TMR0 count
- Transfer the DTC transfer count to memory
- Switch receive buffers
- Reset the DTC transfer count

- (3) As shown in Figure 8-4, when CMIA0 is detected, the program acquires and clears the DTC transfer count and processes the Modbus receive frame in the receive buffer.

- Transmit processing
 - (1) To prepare for transmission, the program performs the following in "Transmission start setting" in Figure 8-4.
 - Set DE (= RE#) to H for transmission
 - To transmit a transmission frame with a TX11, set a transmit buffer and the number of transmit bytes in DTC transfer 3 (DTC_TXI1) and permit transfer
 - Make SCI1 transmit start setting
 - (2) On TXI1 interrupt request, DTC transfer 3 (DTC_TXI1) transfers 1 byte of the transmission frame to the transmission register.
 - (3) On TXI1 interrupt request due to the completion of DTC transfer 3 (DTC_TXI1), the interrupt handler performs the following actions:
 - Enable the transmit end interrupt (TEI1)
 - Disable TXI1 interrupt
 - (4) On TEI1 interrupt, the interrupt handler performs the following actions:
 - Reset TMR0
 - Disable CMIA0 and enable CMIB0
 - Start the TMR0 count
 - Disable TEI1 interrupt
 - (5) On a TMR0 compare match interrupt request (CMIB0), the interrupt handler performs the following actions:
 - Stop the TMR0 count
 - Set DE (= RE#) to L
 - Disable CMIB0 and enable CMIA0

8.3.2.2 Receive Frame Processing

The received self-addressed frame is processed, a response frame is generated, and set transmission.

The processing on receive frames and whether response frames are transmitted are shown in Table 8-18, and the receive frame processing flowchart is shown in Figure 8-5 and Figure 8-6.

Table 8-18 Processing on Receive Frames and Responses

| Receive frame | Processing | Response |
|---------------------------|----------------------|----------------------|
| No frame | None | None |
| Frame addressed to others | Discard | None |
| Broadcast query | Supported processing | None |
| Self-addressed frame | CRC error | Discard |
| | Unsupported query | Discard |
| | Normal | Supported processing |
| | | Exception response |
| | | Response |

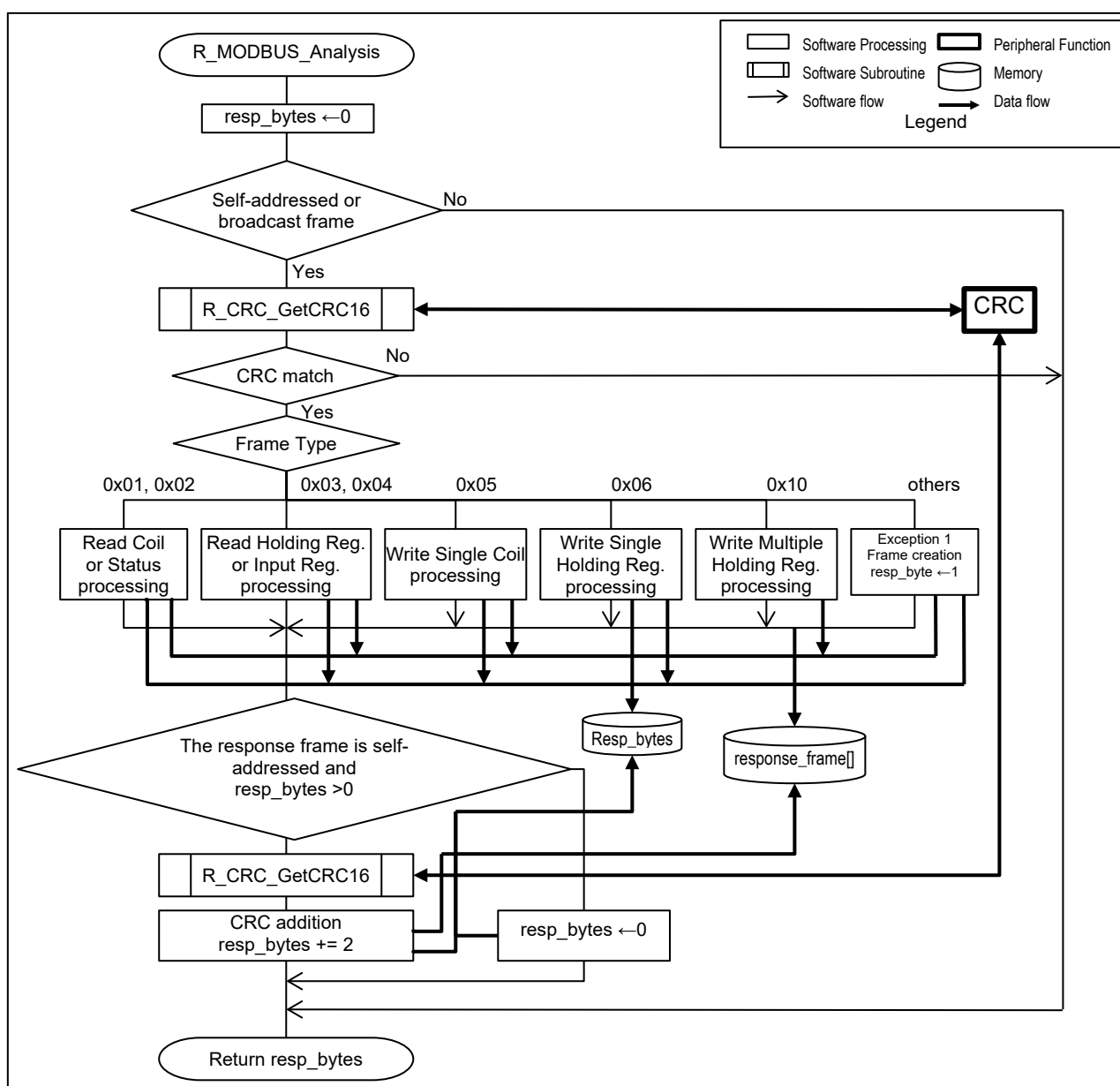


Figure 8-5 Modbus Receive Frame Processing Flow (1)

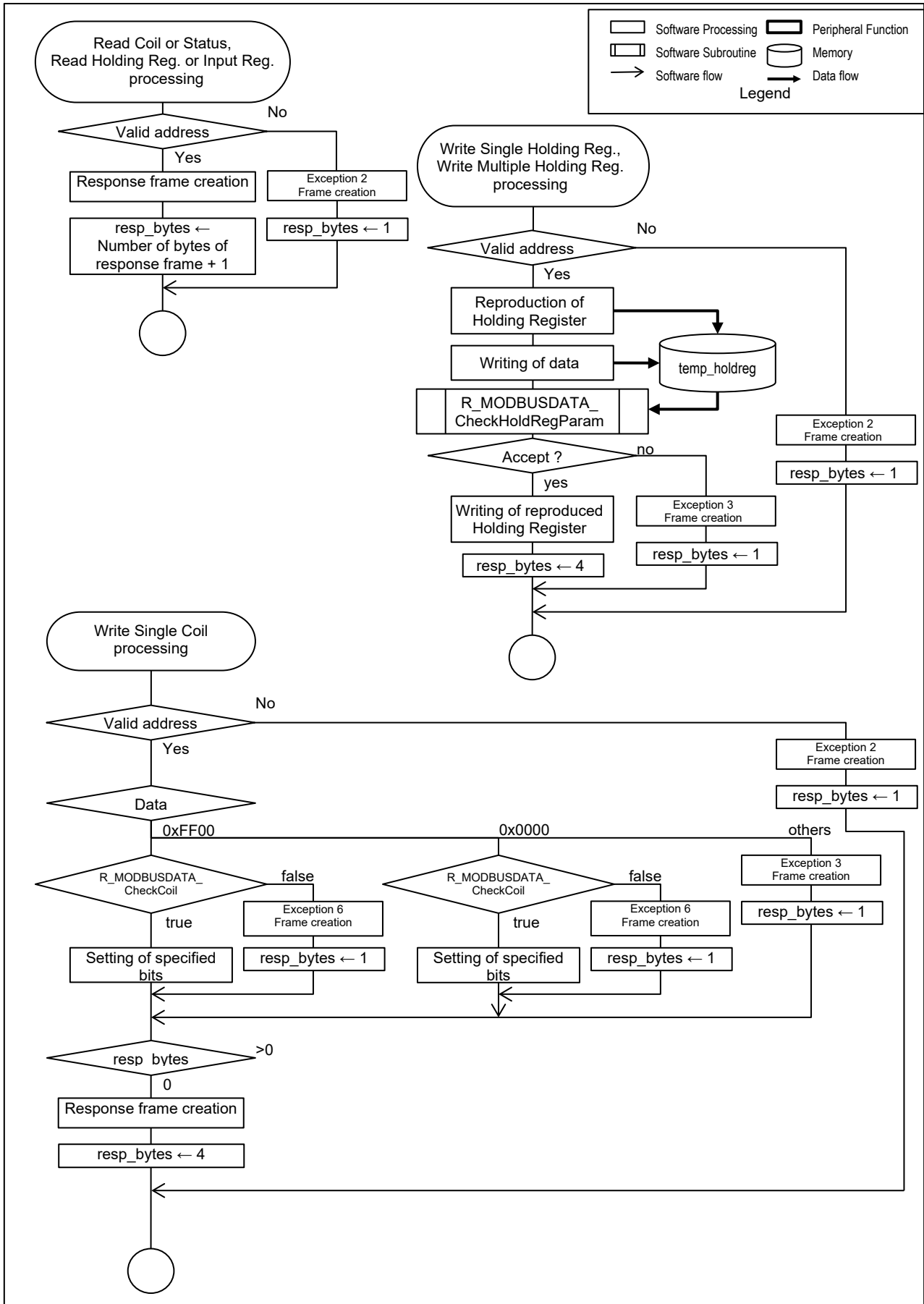


Figure 8-6 Modbus Receive Frame Processing Flow (2)

8.4 Program Configuration

8.4.1 Source File Configuration

Table 8-19 File Configuration

| Folder name, file name | Description | |
|-------------------------------|---|---------------------------------|
| | QE for AFE version | Modbus version |
| dsplib-rxv2 | RX DSP library file | |
| src | | |
| └ smc_gen | Generated by Smart Configurator | |
| ├ └ general | Generated by Smart Configurator | Generated by Smart Configurator |
| ├ └ r_bsp | | |
| ├ └ r_config | | |
| ├ └ r_pincfg | | |
| ├ └ Config_AFE | Force sensor measurement setting | |
| ├ └ Config_DSAD0 | | |
| ├ └ Config_DTC_DSAD0 | A/D conversion result transfer | |
| ├ └ Config_SCI1 | QE for AFE communication | Modbus communication |
| ├ └ Config_DMAC0 | | - |
| ├ └ Config_DMAC1 | | |
| ├ └ Config_DTC_RXI | - | Modbus communication |
| ├ └ Config_DTC_TXI | | |
| ├ └ Config_DTC_CMIA0 | | |
| ├ └ Config_TMR0 | | |
| ├ └ Config_PORT | Settings for LED, SW, and RS-485 transmission/reception switching | |
| ├ └ r_flash_rx | Flash API | |
| └ main.c | Main function | |
| └ r_fs_cfg.h | Force sensor measurement processing | |
| └ r_fs_api.c | | |
| └ r_fs_api.h | | |
| └ r_modbusdata_api.c | Modbus data processing | |
| └ r_modbusdata_api.h | | |
| └ r_modbusdata_cfg.h | | |
| └ r_qe_cfg.h | QE for AFE communication module | - |
| └ r_qe_cfg_typedef.h | | |
| └ r_qe_packet.h | | |
| └ r_qe_sc_if.h | | |
| └ r_qe_api.c | | |
| └ r_qe_api.h | | |
| └ r_qe_api_user.c | | |
| └ r_ring_buffer_control_api.c | | |
| └ r_ring_buffer_control_api.h | | |
| └ r_modbus_cfg.c | - | Modbus communication process |
| └ r_modbus_api.c | | |
| └ r_modbus_api.h | | |

8.4.2 Build Settings

There are two types of sample projects, QE for AFE version and Modbus version, as shown in Table 2-1. Additional settings for each sample project are listed in Table 8-20.

Table 8-20 Build Settings for Sample Projects

| Project name | rx23eb_loadcell_qe | | rx23eb_loadcell_modbus | |
|-------------------------------|---------------------------|----------------------|------------------------|--------------|
| Additional definition | -define D_CFG_QE_TOOL_USE | | None | |
| Additional section definition | Address | Section name | Address | Section name |
| | - | B_MODBUS_HOLDREG_1 | Same as the left | |
| | 0x00100000 | C_DATAFLASH_1 | Same as the left | |
| | 0x00003000 | B_DMAC_REPEAT_AREA_1 | - | - |

8.4.3 Macro Definitions
Table 8-21 r_modbusdata_cfg.h Definitions

| Definition name | value | Description |
|--|-------|--|
| D_MODBUSDATA_CFG_ZERORESET_AVERAGE_DEFAULT | 0 | Initial value of averaging count for zero reset processing |
| D_MODBUSDATA_CFG_ZERORESET_MIN | 64 | Minimum averaging count for zero reset processing |
| D_MODBUSDATA_CFG_ZERORESET_MAX | 512 | Maximum averaging count for zero reset processing |

Table 8-22 r_fs_cfg.h Definitions

| Definition name | value | Description |
|---------------------|-----------------|---|
| D_FS_CFG_VREF | 5.0F | DSAD0 reference voltage V_{REF} [V] |
| D_FS_CFG_DSADRES | 24 | A/D value resolution [bits] |
| D_FS_CFG_CHANNELS | 6 | Number of channels DSAD0 uses |
| D_FS_CFG_CONVMATRIX | Identity matrix | Force sensor voltage-load conversion matrix |

Table 8-23 r_modbus_cfg.h Definitions (Modbus Version)

| Definition name | value | Description |
|----------------------|-------|----------------------|
| D_MODBUS_CFG_ADDRESS | 0x01 | Modbus slave address |

RX23E-B Group Design and measurement of small board for 6-axis force sensor

Table 8-24 r_qe_cfg.h Definitions (QE for AFE Version)

| Definition name | value | Description |
|--------------------------|--|--|
| D_QE_CFG_TX_RINGBUF_SIZE | 512U | Transmission ring buffer size [byte] |
| D_QE_CFG_RX_RINGBUF_SIZE | 512U | Reception ring buffer size [byte] |
| D_QE_CFG_FORMAT_REV | 3 | Communication specifications revision |
| D_QE_CFG_READ | 1 | Register read permission |
| D_QE_CFG_WRITE | 1 | Register write permission |
| D_QE_CFG_USER_VAL0 | 1 | User Value setting 0: Not used 1: Used |
| D_QE_CFG_USER_VAL1 | 0 | |
| D_QE_CFG_USER_VAL2 | 0 | |
| D_QE_CFG_USER_VAL3 | 0 | |
| D_QE_CFG_USER_VAL4 | 0 | |
| D_QE_CFG_USER_VAL5 | 0 | |
| D_QE_CFG_USER_VAL6 | 0 | |
| D_QE_CFG_USER_VAL7 | 0 | |
| D_QE_CFG_EX_SPS | 1 | SPS information support 0: Not used 1: Used |
| D_QE_CFG_EX_USER_BTN0 | 1 | User Button use settings 0: Not used 1: Used |
| D_QE_CFG_EX_USER_BTN1 | 1 | |
| D_QE_CFG_EX_USER_BTN2 | 0 | |
| D_QE_CFG_EX_USER_BTN3 | 0 | |
| D_QE_CFG_EX_USER_BTN4 | 0 | |
| D_QE_CFG_EX_USER_BTN5 | 0 | |
| D_QE_CFG_EX_USER_BTN6 | 0 | |
| D_QE_CFG_EX_USER_BTN7 | 0 | |
| D_QE_CFG_CH0 | 0x3 | Data transmission CH use setting 0x3: Measurement value transmission 0x0: Not used |
| D_QE_CFG_CH1 | 0x3 | |
| D_QE_CFG_CH2 | 0x3 | |
| D_QE_CFG_CH3 | 0x3 | |
| D_QE_CFG_CH4 | 0x3 | |
| D_QE_CFG_CH5 | 0x3 | |
| D_QE_CFG_CH6 | 0x0 | |
| D_QE_CFG_CH7 | 0x0 | |
| D_QE_CFG_CH8 | 0x0 | |
| D_QE_CFG_CH9 | 0x0 | |
| D_QE_CFG_CH10 | 0x0 | |
| D_QE_CFG_CH11 | 0x0 | |
| D_QE_CFG_CH12 | 0x0 | |
| D_QE_CFG_CH13 | 0x0 | |
| D_QE_CFG_CH14 | 0x0 | |
| D_QE_CFG_CH15 | 0x0 | |
| D_QE_CFG_TXT_INFO | " RX23E-B 6-axis force sensor measurement" | Program information |
| D_QE_CFG_TXERRCHK_EN | 0 | Transmission error detection enabled |
| D_QE_CFG_TIMEOUT | 0 | Error is detected when timeout is reached |
| D_QE_CFG_SCI | 0 | SCI channel number used for communication |
| D_QE_CFG_DMACH_RX | 0 | DMAC channel for reception |
| D_QE_CFG_DMACH_TX | 1 | DMAC channel for transmission |
| D_QE_CFG_CMT | 0 | CMT number for timeout detection |

8.4.4 Structures, Unions, and Enumeration Types

Table 8-25 main.c List

| | | | |
|----------------------------|-------------|------------------------|---------------------------|
| Structure type name | | st_zeroreset_param_t | |
| Description | | Zero reset parameters | |
| Member | Type | Name | Description |
| | uint16_t | num | Averaging count |
| | uint16_t | count | Input count |
| | float | sum[D_FS_CFG_CHANNELS] | Total value storage array |

Table 8-26 r_modbusdata_api.h List (1/3)

| | | | |
|------------------------------|---------------|---------------------------|--------------------|
| Structure type name | | u_modbus_float_t | |
| Description | | float type Modbus data | |
| Member | Type | Name | Description |
| | float | float32 | Float type |
| | uint32_t | uint32 | uint32 type |
| | uint16_t | word[2] | uint16 type |
| | uint8_t | byte[4] | uint8 type |
| Structure type name | | u_modbus_long_t | |
| Description | | int32_t type Modbus data | |
| Member | Type | Name | Description |
| | int32_t | int32 | int32 type |
| | uint16_t | word[2] | uint16 type |
| | uint8_t | byte[4] | uint8 type |
| Structure type name | | u_modbus_ulong_t | |
| Description | | uint32_t type Modbus data | |
| Member | Type | Name | Description |
| | uint32_t | int32 | uint32 type |
| | uint16_t | word[2] | uint16 type |
| | uint8_t | byte[4] | uint8 type |
| Structure type name | | u_modbus_ushort_t | |
| Description | | uint16_t type Modbus data | |
| Member | Type | Name | Description |
| | uint16_t | word | uint16 type |
| | uint8_t | byte[2] | uint8 type |
| Enumeration type name | | e_opemode_t | |
| Description | | Operation mode | |
| Member | Name | Value | Description |
| | E_IDLE | 0 | Standby |
| | E_MEASUREMENT | 1 | Measurement |
| | E_ZERORESET | 2 | Zero reset |

Table 8-27 r_modbusdata_api.h List (2/3)

| | | | |
|------------------------|----------------|---|------------------------------|
| Union type name | | u_modbusdata_coil_t | |
| Description | | Modbus Coil | |
| Member | Type | Name | Description |
| | uint32_t | uint32 | Entire data |
| | union | bit | Access in bit units |
| | uint32_t:2 | ope_mode | Operating mode bit group |
| | struct | flag | Each bit |
| | uint32_t:1 | measure | Measurement mode bit |
| | uint32_t:1 | zero_reset | Zero reset bit |
| | uint32_t:1 | reset_param | Parameter initialization bit |
| uint32_t:1 | register_write | Register rewriting bit (for QE for AFE) | |
| Union type name | | u_modbusdata_status_t | |
| Description | | Modbus Status | |
| Member | Type | Name | Description |
| | uint32_t | uint32 | Entire data |
| | union | status | Access in bit units |
| | struct | bit | Each bit |
| | uint32_t:1 | dsad0_ovf | DSAD0 CH0 Overflow bit |
| | uint32_t:1 | dsad0_err | DSAD0 CH0 Error bit |
| | uint32_t:1 | dsad1_ovf | DSAD0 CH1 Overflow bit |
| | uint32_t:1 | dsad1_err | DSAD0 CH1 Error bit |
| | uint32_t:1 | dsad2_ovf | DSAD0 CH2 Overflow bit |
| | uint32_t:1 | dsad2_err | DSAD0 CH2 Error bit |
| | uint32_t:1 | dsad3_ovf | DSAD0 CH3 Overflow bit |
| | uint32_t:1 | dsad3_err | DSAD0 CH3 Error bit |
| | uint32_t:1 | dsad4_ovf | DSAD0 CH4 Overflow bit |
| | uint32_t:1 | dsad4_err | DSAD0 CH4 Error bit |
| | uint32_t:1 | dsad5_ovf | DSAD0 CH5 Overflow bit |
| | uint32_t:1 | dsad5_err | DSAD0 CH5 Error bit |

Table 8-28 r_modbusdata_api.h List (3/3)

| | | | |
|------------------------|-------------------|---|---|
| Union type name | | u_modbusdata_inputreg_t | |
| Description | | Modbus Input register | |
| Member | Type | Name | Description |
| | uint16_t | reg[24] | Access in register units |
| | struct | member | Each register definition |
| | u_modbus_float_t | fx | X-axis force |
| | u_modbus_float_t | fy | Y-axis force |
| | u_modbus_float_t | fz | Z-axis force |
| | u_modbus_float_t | tx | X-axis torque |
| | u_modbus_float_t | ty | Y-axis torque |
| | u_modbus_float_t | tz | Z-axis torque |
| | u_modbus_long_t | dsad0_ad | CH0 A/D value |
| | u_modbus_long_t | dsad1_ad | CH1 A/D value |
| | u_modbus_long_t | dsad2_ad | CH2 A/D value |
| | u_modbus_long_t | dsad3_ad | CH3 A/D value |
| | u_modbus_long_t | dsad4_ad | CH4 A/D value |
| | u_modbus_long_t | dsad5_ad | CH5 A/D value |
| | struct | params | Internal access definition |
| | float | result[6] | Matrix calculation output |
| | int32_t | adval[6] | A/D value array |
| Union type name | | u_modbusdata_holdreg_t | |
| Description | | Modbus Holding register | |
| Member | Type | Name | Description |
| | uint16_t | reg [(D_FS_CFG_CHANNELS * D_FS_CFG_CHANNELS + D_FS_CFG_CHANNELS) * 2 + 1] | Access in register units |
| | struct | member | Each register definition |
| | u_modbus_float_t | matrix [D_FS_CFG_CHANNELS] [D_FS_CFG_CHANNELS] | Voltage-load conversion matrix |
| | u_modbus_long_t | ofcr0 | DSAD0 CH0 offset correction value |
| | u_modbus_long_t | ofcr1 | DSAD0 CH1 offset correction value |
| | u_modbus_long_t | ofcr2 | DSAD0 CH2 offset correction value |
| | u_modbus_long_t | ofcr3 | DSAD0 CH3 offset correction value |
| | u_modbus_long_t | ofcr4 | DSAD0 CH4 offset correction value |
| | u_modbus_long_t | ofcr5 | DSAD0 CH5 offset correction value |
| | u_modbus_ushort_t | average | Averaging count for zero reset |
| | struct | params | Internal access definition |
| | float | matrix [D_FS_CFG_CHANNELS] [D_FS_CFG_CHANNELS] | Voltage-load conversion matrix |
| | int32_t | ofcrs [D_FS_CFG_CHANNELS] | Offset correction value array for each channel of DSAD0 |
| | uint16_t | average | Averaging count for zero reset |

8.4.5 Functions

8.4.5.1 Common Functions

Table 8-29 main.c

| | | | | |
|----------------------|---------------|-------------|-------------|--------------------|
| Function name | main | | | |
| Description | main function | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | void | - | |

Table 8-30 r_fs_api

| | | | | |
|----------------------|----------------------------------|-------------|-------------|--------------------|
| Function name | R_FS_DsadToVoltage | | | |
| Description | Converts an A/D value to voltage | | | |
| Argument | I/O | Type | Name | Description |
| | I | float | dsad | A/D value |
| | I | float | gain | PGA gain |
| Return value | O | float | Voltage [V] | |

Table 8-31 r_modbusdata_api (1/2)

| | | | | |
|----------------------|---|---------------------------|------------------------------------|--------------------|
| Function name | R_MODBUSDATA_GetCoilPtr | | | |
| Description | Acquires a pointer to Modbus Coil | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | u_modbusdata_coil_t * | Pointer to Modbus Coil | |
| Function name | R_MODBUSDATA_GetStatusPtr | | | |
| Description | Acquires a pointer to Modbus Status | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | u_modbusdata_status_t * | Pointer to Modbus Status | |
| Function name | R_MODBUSDATA_GetInputRegPtr | | | |
| Description | Acquires a pointer to Modbus Input register | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | u_modbusdata_inputreg_t * | Pointer to Modbus Input register | |
| Function name | R_MODBUSDATA_GetHoldRegPtr | | | |
| Description | Acquires a pointer to Modbus Holding register | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | u_modbusdata_holdreg_t * | Pointer to Modbus Holding register | |

Table 8-32 r_modbusdata_api (2/2)

| | | | | |
|----------------------|---|--------------------------|---|---|
| Function name | R_MODBUSDATA_LoadHoldReg | | | |
| Description | Initializes the Modbus Holding Register and loads the values stored in E2 data flash | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | - |
| Function name | R_MODBUSDATA_SaveHoldReg | | | |
| Description | If the value retained in the Modbus Holding Register does not match the value stored in E2 data flash, stores that value in E2 data flash | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | - |
| Function name | R_MODBUSDATA_ResetHoldReg | | | |
| Description | Set the Modbus Holding Register to the initial value | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | - |
| Function name | R_MODBUSDATA_CheckCoil | | | |
| Description | Judges whether it is possible to clear the specified address of Coil | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint16_t | addr | Coil address |
| | I | bool | flag | true: Set false: Clear |
| Return value | O | bool | true: Possible false: Not possible | |
| Function name | R_MODBUSDATA_CheckHoldRegParam | | | |
| Description | Judges the acceptability of the Holding register value | | | |
| Argument | I/O | Type | Name | Description |
| | I | u_modbusdata_holdreg_t * | p_holdreg | Pointer to the Holding Register union variable to be judged |
| Return value | O | bool | true: Acceptable false: Unacceptable | |

Table 8-33 Config_DSAD0 User-Defined Functions

| | | | | |
|----------------------|---|-------------|---------------------------------------|-----------------------------------|
| Function name | R_DSAD0_IsScanEnd | | | |
| Description | Detects DSAD0 channel scan end (SCANEND0) | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | bool | true: Detected false: Not detected | |
| Function name | R_DSAD0_CONV_SIGNED_VALUE | | | |
| Description | Acquires a signed A/D value (macro function) | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | val | Acquired DR register value |
| Return value | O | int32_t | Signed A/D value | |
| Function name | R_DSAD0_GET_ERROR_FLAGS | | | |
| Description | Extracts the ERR flag and the OVF flag from the acquired DR register value (macro function) | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | val | Acquired DR register value |
| Return value | O | uint32_t | DR.ERR flag and DR.OVF flag | |
| Function name | R_DSAD0_GetScanRate | | | |
| Description | Calculates the channel scan rate of the enabled channel of DSAS0 | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | float | Channel scan rate [scan/s] | |
| Function name | R_Config_DSAD0_SetOFCR | | | |
| Description | Set a value to OFCRm register of DSAD0 | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | ch | Channel m to which to set a value |
| | I | int32_t | ofs | OFCRm register setting value |
| Return value | O | bool | true: Successful false: Failed | |
| Function name | R_Config_DSAD0_GetOFCR | | | |
| Description | Acquires the OFCRm register value of DSAD0 | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | ch | Channel m to which to set a value |
| Return value | O | int32_t | OFCRm register value | |

Table 8-34 Config_DTC_DSAD0 User-Defined Functions

| | | | | |
|----------------------|---|-------------|------------------------------|--------------------|
| Function name | R_Config_DTC_DSAD0_SetSrcAddr | | | |
| Description | Sets the source address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | void * | addr | Source address |
| Return value | - | void | - | |
| Function name | R_Config_DTC_DSAD0_ResetCount | | | |
| Description | Resets the remaining DTC transfer count | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | CRA address | |
| Function name | R_Config_DTC_DSAD0_GetCount | | | |
| Description | Acquires the remaining DTC transfer count | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | uint8_t | Remaining DTC transfer count | |

Table 8-35 Config_PORT User-Defined Functions

| | | | | |
|----------------------|--|-------------|------------------------|---------------------------------|
| Function name | R_CONFIG_PORT_LED1_ON | | | |
| Description | Turns LED ON/OFF (macro functions) | | | |
| Argument | I/O | Type | Name | Description |
| | I | bool | flag | true: ON false: OFF |
| Return value | - | void | - | |
| Function name | R_PORT_GetSwitchOn | | | |
| Description | Acquires the state of SW1 | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | bool | true: On false: Off | |
| Function name | R_CONFIG_PORT_SET_DE | | | |
| Description | Sets the transmission or reception of the RS-485 driver (macro function) | | | |
| Argument | I/O | Type | Name | Description |
| | - | uint8_t | value | 0: Reception 1: Transmission |
| Return value | - | void | - | |

8.4.5.2 QE for AFE Version

Table 8-36 r_qe_api_user.c User-Defined Processes

User processes only

| | |
|----------------------|--|
| Function name | r_QE_WriteUser |
| Description | If ope_mode is E_IDLE, accepts and sets coil.flag.register_write |
| Function name | r_QE_RunUser |
| Description | If ope_mode is E_IDLE, accepts and sets coil.flag.measure |
| Function name | r_QE_StopUser |
| Description | Resets coil.flag.measure |
| Function name | r_QE_UserValueUser^{Note} |
| Description | Judges to be accepted or not for each User Value No., and if accepted, updates the value of the corresponding Holding register |
| Function name | r_QE_ExSpsInfoUser |
| Description | Calculates the output rate from the DSAD0 settings and updates SPS information |
| Function name | r_QE_ExUseButtonStatusUser^{Note} |
| Description | Judges to be accepted or not for each Button No., and if accepted, sets the flag for the corresponding Coil |
| Function name | r_QE_ResetUser |
| Description | Sets the RS-485 driver to the receive status (DE = L) |

Note: For details about each of the corresponding QE for AFE functions, refer to Table 1-1.

Table 8-37 r_qe_api.c Processing Modification

Modification only

| | |
|----------------------|---|
| Function name | R_QE_TxStart |
| Description | Sets the RS-485 driver to the transmit status (DE = H) at the start of transmission |

8.4.5.3 Modbus Version

Table 8-38 r_modbus_api

| | | | | |
|----------------------|--|----------------|---|--|
| Function name | R_MODBUS_Analysis | | | |
| Description | Inspects and analyzes the receive frame, processes the corresponding Modbus data, and creates a transmission frame | | | |
| Argument | I/O | Type | Name | Description |
| | I | const uint8_t* | QueryFrame | Pointer to the receive frame |
| | I | uint32_t | QueryBytes | Number of bytes of the receive frame |
| | O | uint8_t* | ResponseFrame | Pointer to the destination to store the transmission frame |
| Return value | O | uint32_t | Number of bytes of the transmission frame | |

Table 8-39 Config_CRC User-Defined Functions

| | | | | |
|----------------------|-----------------------|-------------|--------------|-----------------------------|
| Function name | R_CRC_GetCRC16 | | | |
| Description | Calculates CRC-16 | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint8_t | array | Pointer to the target array |
| | I | uint32_t | num | Number of target bytes |
| Return value | O | uint16_t | CRC-16 value | |

Table 8-40 Config_TMR0 User-Defined Functions

| | | | | |
|----------------------|--|-------------|---------------------------------------|--------------------------------|
| Function name | R_Config_TMR0_SetCMIA0 R_Config_TMR0_SetCMIB0 | | | |
| Description | Sets CMIX0 interrupt enable/disable | | | |
| Argument | I/O | Type | Name | Description |
| | I | bool | enable | true: Enable false: Disable |
| Return value | - | void | - | |
| Function name | R_Config_TMR0_ClearCount | | | |
| Description | Clears the timer count value | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | |
| Function name | R_Config_TMR0_StartCount | | | |
| Description | Starts the timer count | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | |
| Function name | R_Config_TMR0_StopCount | | | |
| Description | Stops the timer count | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | - | void | - | |
| Function name | R_TMR0_IsCMIA0 | | | |
| Description | Detects a CMIA0 interrupt request | | | |
| Argument | I/O | Type | Name | Description |
| | - | void | - | - |
| Return value | O | bool | true: Detected false: Not detected | |

Table 8-41 Config_DTC_RXI1 User-Defined Functions

| | | | | |
|----------------------|--|-------------|-------------|-----------------------|
| Function name | R_Config_DTC_RXI1_SetDstAddr | | | |
| Description | Sets the destination address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| | I | void * | addr | Destination address |
| Return value | - | void | - | |
| Function name | R_Config_DTC_RXI1_SetSrcAddr | | | |
| Description | Sets the source address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| | I | void * | addr | Source address |
| Return value | - | void | - | |
| Function name | R_Config_DTC_RXI1_GetCraAddr | | | |
| Description | Acquires the CRA address in DTC transfer information | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| Return value | O | void * | CRA address | |
| Function name | R_Config_DTC_RXI1_GetDarAddr | | | |
| Description | Acquires the DAR address in DTC transfer information | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| Return value | O | void * | DAR address | |

Table 8-42 Config_DTC_TXI1 User-Defined Functions

| | | | | |
|----------------------|--|-------------|-------------|--------------------------|
| Function name | R_Config_DTC_TXI1_SetCount | | | |
| Description | Sets the destination address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | count | Number of transfer bytes |
| Return value | - | void | - | |
| Function name | R_Config_DTC_TXI1_SetSrcAddr | | | |
| Description | Sets the source address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | void * | addr | Source address |
| Return value | - | void | - | |

Table 8-43 Config_DTC_CMIA0 User-Defined Functions

| | | | | |
|----------------------|--|-------------|-------------|-----------------------|
| Function name | R_Config_DTC_CMIA0_SetDstAddr | | | |
| Description | Sets the destination address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| | I | void * | addr | Destination address |
| Return value | - | void | - | |
| Function name | R_Config_DTC_CMIA0_SetSrcAddr | | | |
| Description | Sets the source address of DTC transfer | | | |
| Argument | I/O | Type | Name | Description |
| | I | uint32_t | number | Chain transfer number |
| | I | void * | addr | Source address |
| Return value | - | void | - | |

9. Importing a Project

After importing the sample project, make sure to confirm build and debugger setting.

9.1 Importing a Project into e2 studio

Follow the steps below to import your project into e² studio. Pictures may be different depending on the version of e² studio to be used.

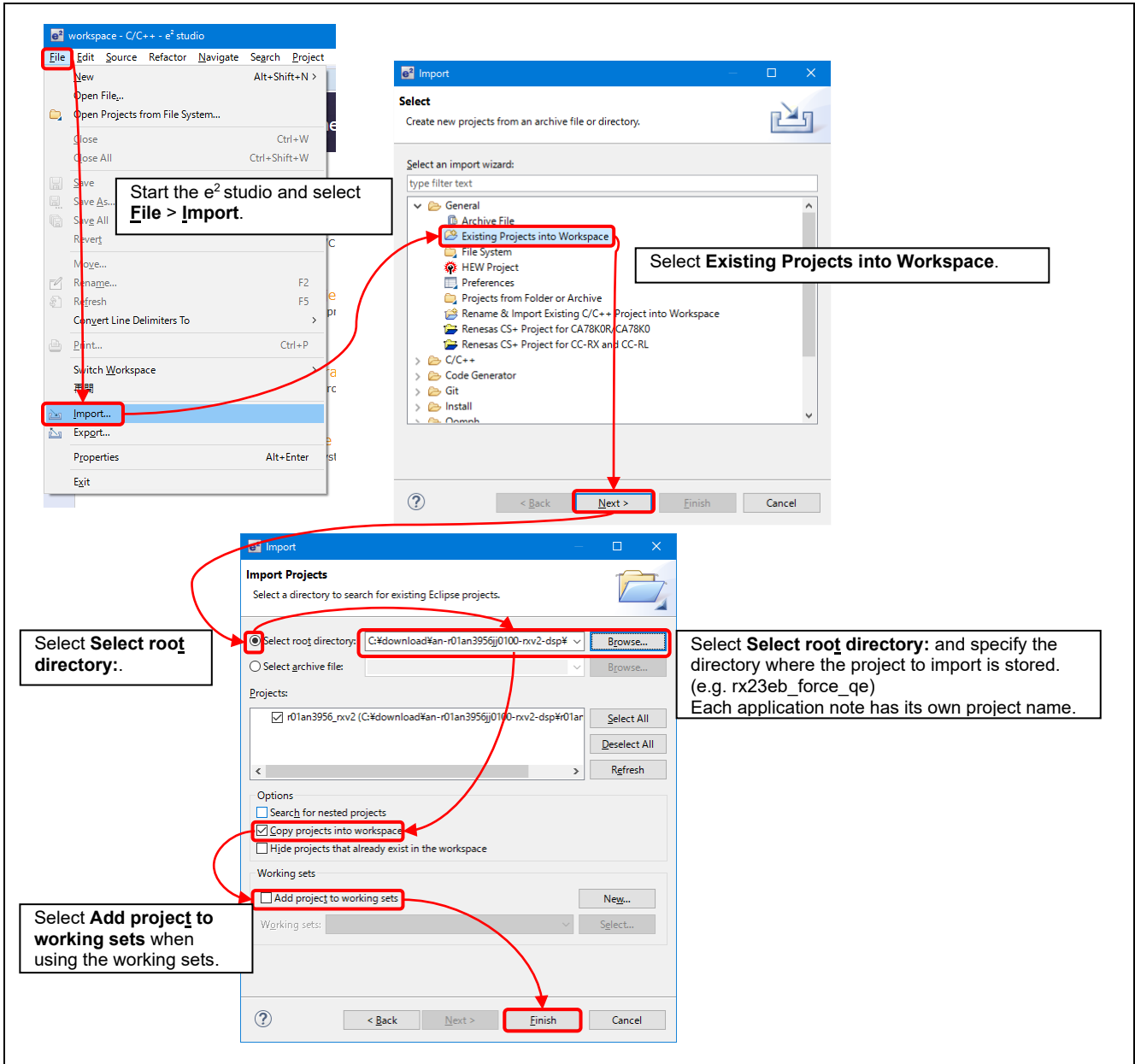


Figure 9-1 Importing a project into e² studio

9.2 Importing a Project into CS+

Follow the steps below to import your project into CS+. Pictures may be different depending on the version of CS+ to be used.

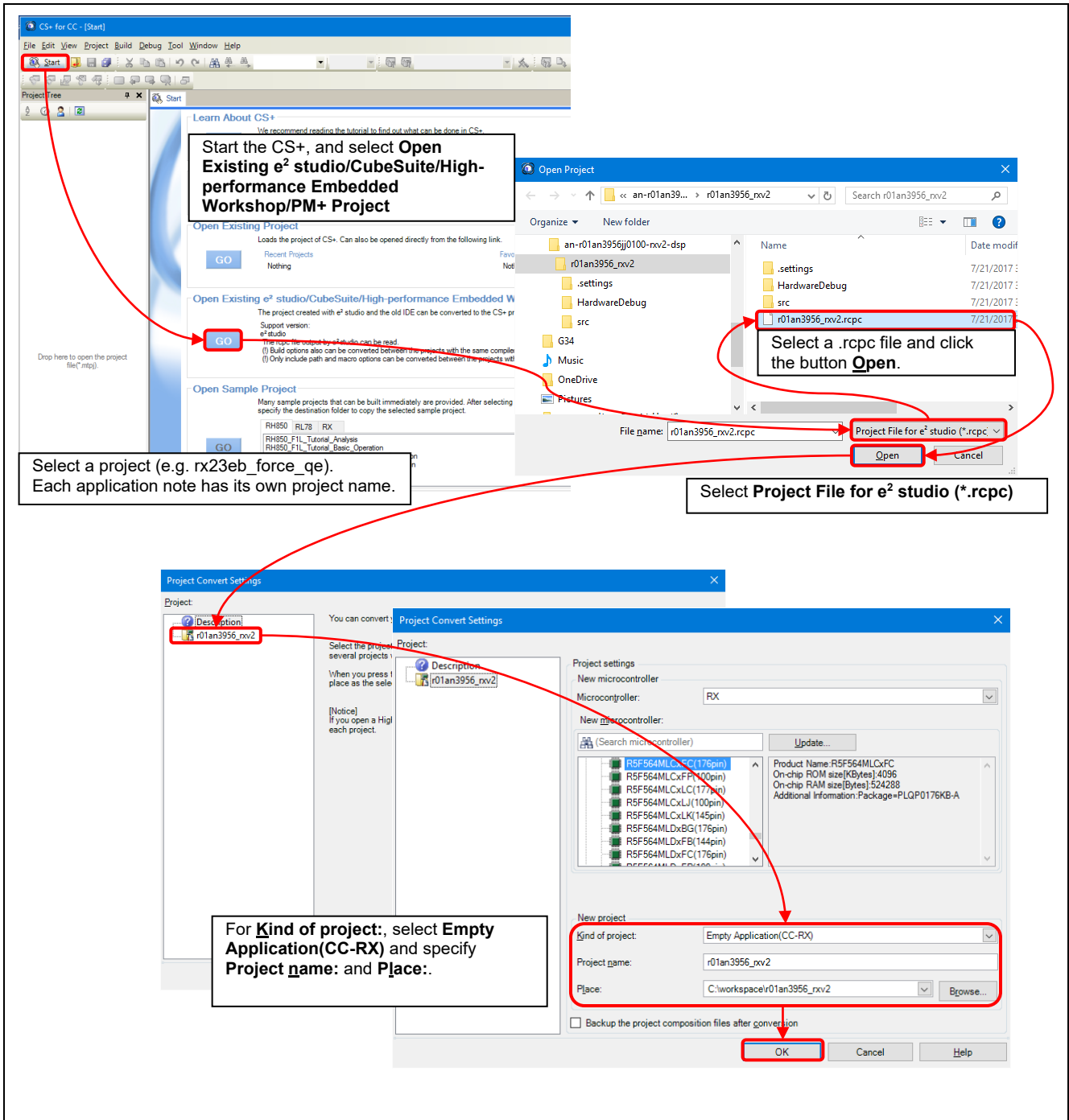


Figure 9-2 Importing a project into CS+

10. Operation on Renesas Solution Starter Kit for RX23E-B Board

The Renesas Solution Starter Kit for RX23E-B (hereafter, referred to as RSSKRX23E-B) is offered for the evaluation of RX23E-B. The RSSKRX23E-B board contains the R5F523E6LxFP in the QFP100 package and supports various sensor measurements.

This sample program can be run on the RSSKRX23E-B board by changing settings with the Smart Configurator. Communication can be conducted via the USB-UART conversion IC.

The following explains an example of connection between the RSSKRX23E-B board and the force sensor and the procedure for changing the sample project.

(1) Connection to RSSKRX23E-B board

Figure 10-1 shows the connection example, Table 10-1 shows the changes to component constants, and Table 10-2 shows the jumper settings. In this connection example, the force sensor output is connected to AIN9, AIN8, AIN7, AIN6, AIN5, and AIN4 as positive input signal of DSAD0. For negative input signal of DSAD0, the RX23E-B bias voltage generator VBIAS is used to apply the half voltage of AVCC0 to AIN10. To measure the sensor output, the voltages of AIN9, AIN8, AIN7, AIN6, AIN5, and AIN4 for AIN10 are sequentially A/D converted by using the channel function of DSAD0, and the A/D conversion results of 6 channels are converted into the force and torque.

If a voltage different from AVCC0 is applied to the force sensor, or if a high-precision reference voltage is required, generate the voltage by an external circuit and input it to AIN10. If the external voltage is input to AIN10, it is necessary to disable the VBIAS output of the RX23E-B, mount 0Ω resistors on R175 and R196, and remove R197.

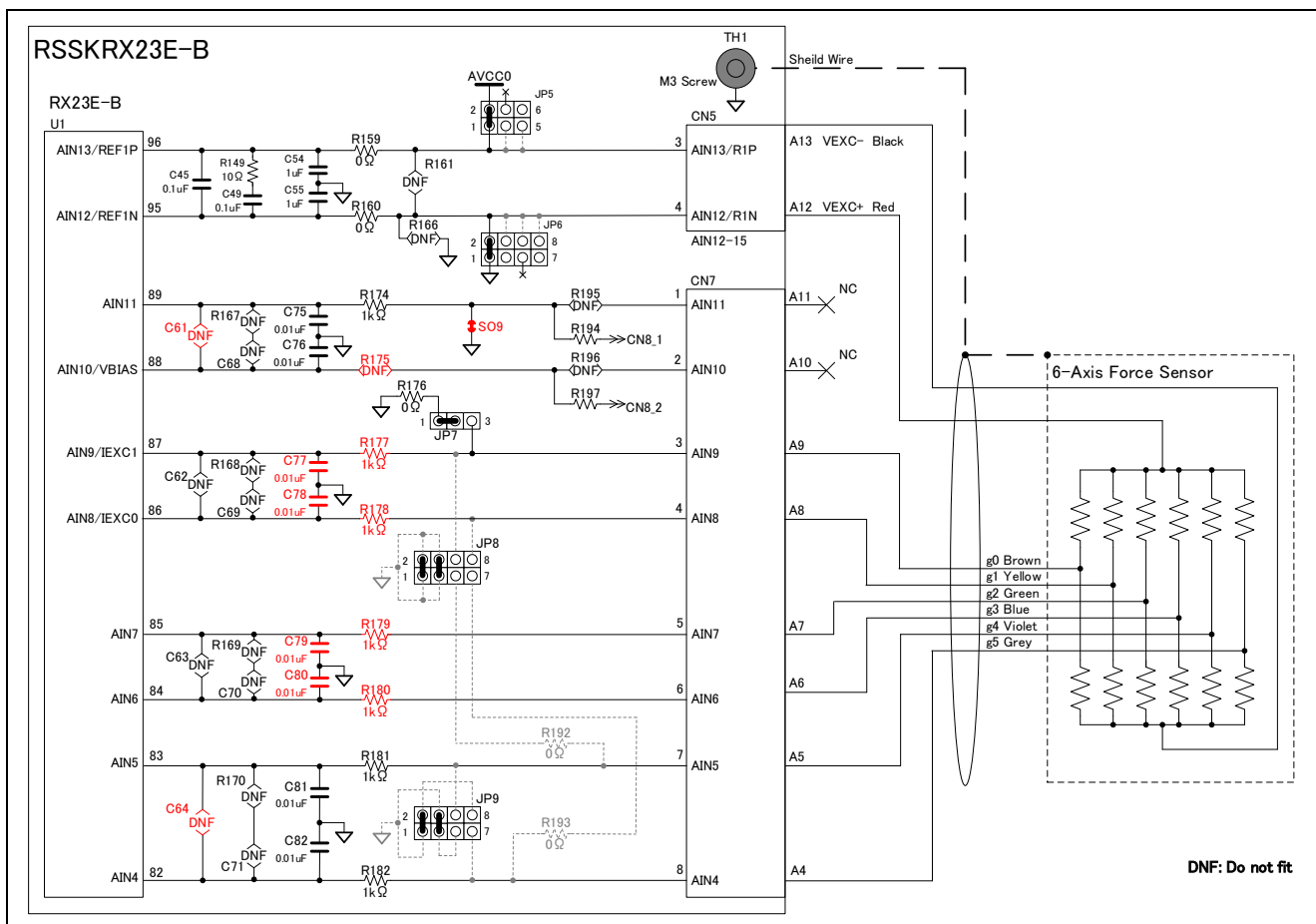


Figure 10-1 Example of connecting RSSKRX23E-B Board to Force Sensor

Table 10-1 Changes to RSSKRX23E-B Board for Force Sensor Connection

| Circuit Code | Before change | After change |
|------------------------|---------------|------------------------|
| R175 | 1kΩ | DNF |
| R177, R178, R179, R180 | 0Ω | 1kΩ ^{Note} |
| C61, C64 | 0.1μF | DNF |
| C77, C78, C79, C80 | DNF | 0.01μF ^{Note} |
| SO9 | Open | Short |

Note: The component constants are reference values. Change them based on operating conditions and target performance.

Table 10-2 Jumper Settings for RSSKRX23E-B Board for Force Sensor Connection

| Function | Code | Connection | Setting |
|---|------|-------------|---|
| External reference REF1P selection | JP5 | 1-2 | Input AVCC0 to REF1P |
| External reference REF1N selection | JP6 | 1-2 | Input AVSS0 to REF1N |
| AIN9 onboard RTD connection selection | JP7 | 1-2 | AIN9: No connection to RTD1 |
| 3-wire RTD connection selection | JP8 | 1-2 and 3-4 | AIN8, AIN9: No connection to AIN4, AIN5 |
| AIN4, AIN5 onboard RTD connection selection | JP9 | 1-2 and 3-4 | AIN5, AIN4: No connection to RTD |

(2) Change the device type name

Click the button next to “Board” on the "Board" tab, and then change "Target device" to R5F523E6LxFP then uncheck the “Sections (-start)” in HardwareDebug_RSSK on “Changes to be performed” in the “Change Device” dialog.

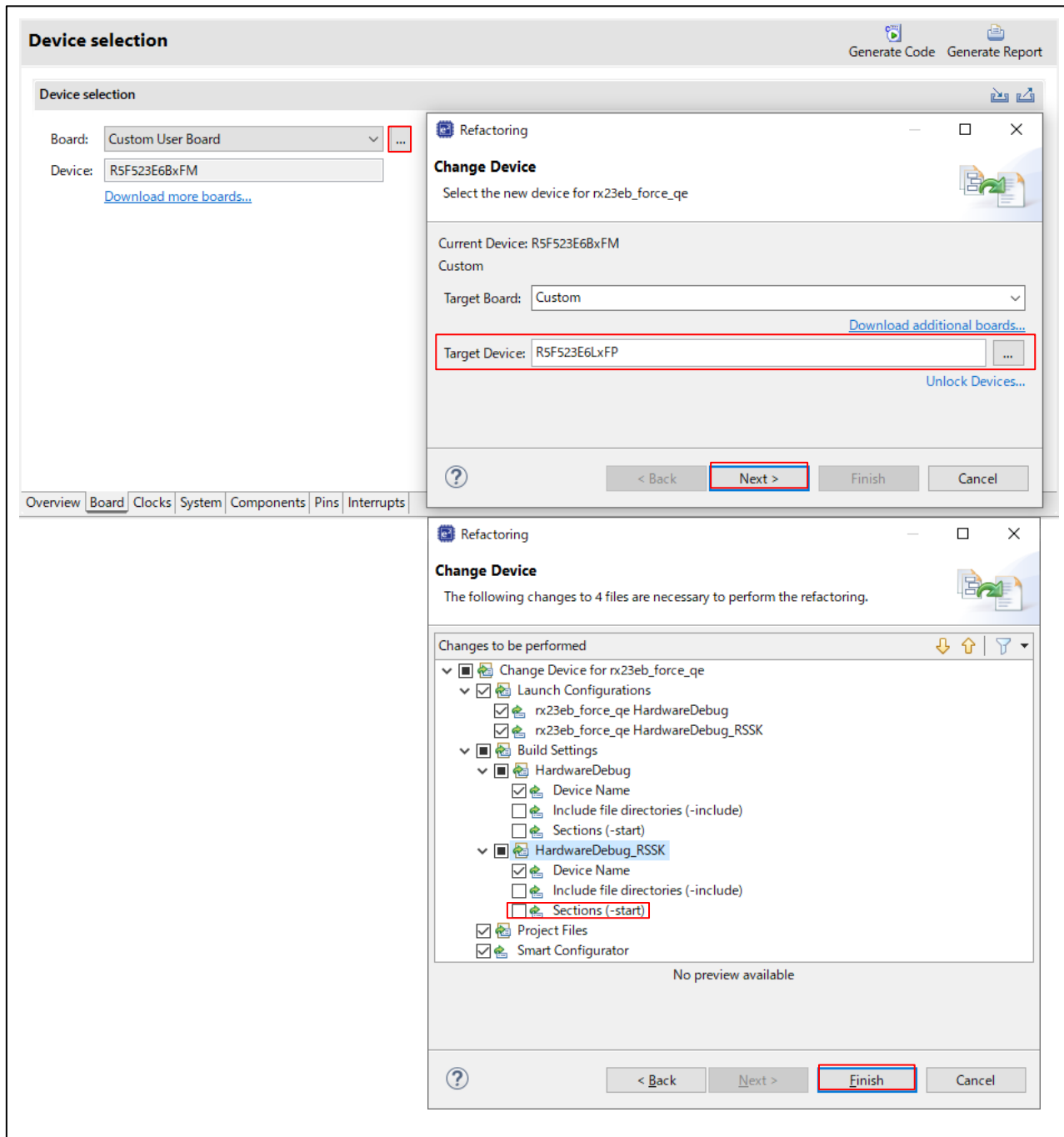


Figure 10-2 Changing the Target Device

RX23E-B Group Design and measurement of small board for 6-axis force sensor

(3) Change AFE and DSAD settings

On the “Component” tab, change the settings for DSAD0 and AFE, and then generate code.

— DSAD0 setting

Change the analog input settings of channel 0 to 5 with Config_DSAD0 according to Table 10-3. Bold text in the table indicates changes.

Table 10-3 DSAD0 Settings for RSSKRX23E-B

Continuous scan mode

| Item | | Setting | | | | | |
|------------------------------|-----------------------------------|--------------|-------------|-------------|-------------|-------------|-------------|
| | | 0 | 1 | 2 | 3 | 4 | 5 |
| Analog input channel setting | | | | | | | |
| Analog input setting | Positive input signal | AIN9 | AIN8 | AIN7 | AIN6 | AIN5 | AIN4 |
| | Negative input signal | AIN10 | | | | | |
| | Reference input | REF0P/REF0N | | | | | |
| | Positive reference voltage buffer | Disable | | | | | |
| | Negative reference voltage buffer | Disable | | | | | |

— AFE setting

If using VBIAS for negative input signal of DSAD0, select the bias voltage output pin with Config_AFE as shown in Table 10-4. Bold text in the table indicates changes.

Table 10-4 AFE Settings for RSSKRX23E-B

| Item | | Setting |
|---------------------|----------------------------|---------------|
| Bias output setting | Enable bias voltage output | Enable |
| | AIN2 output pin | Disable |
| | AIN10 output pin | Enable |

(4) Build

Change the active build configuration to “HardwareDebug_RSSK”, then build.

To run the product on the RSSKRX23E-B board, pin settings have been changed using the R_Config_PORT_Create_UserInit function in Config_PORT_user.c, according to Table 10-5. In addition, assignment of LED1 port and SW1 port are changed using Config_PORT.h.

Table 10-5 RSSKRX23E-B Pin Used

| RX23E-B-QFP64-FT | RSSKRX23E-B board | | | |
|---|-------------------|----------|---------------------|--------------------|
| Pin: Function | Assignment | Pin | Initial setting | Supplement |
| P31: Switches the setting of RS-485 driver between transmit/receive | DE | PC6 | Output: L | RAA7881582/DE |
| PC3: LED1 | LED0 | P70 | Output: H | |
| - | LED1 | P71 | Output: H | |
| - | LED2 | P72 | Output: H | |
| - | LED3 | P73 | Output: H | |
| PC4: SW1 | SW1 | PE1 | Input | |
| - | SW2 | PE2 | Input | |
| - | SW3-1 | PE3 | Input | |
| - | SW3-2 | PE4 | Input | |
| - | XTAL | P36, P37 | Peripheral function | XTAL is unused |
| - | - | P15 | Input | CTS1#Input |
| - | - | PC1 | Input | MAX13053/RXD Input |

Note: Set I/O ports not listed above to output: L.

11. Measurement Results with Sample Program

11.1 Memory Usage and Number of Execution Cycles

11.1.1 Build Conditions

The build conditions for the sample program are listed in Table 11-1

Table 11-1 Build Conditions

| Item | | Setting | |
|----------|------------|---|---|
| | | QE for AFE | modbus |
| Compiler | Common | -isa=rxv2 -fpu -include="{workspace_loc}/{ProjName}/dsplib-rxv2}" -utf8 -nomessage -output=obj -obj_path="{workspace_loc}/{ProjName}/{ConfigName}" -debug -outcode=utf8 -nologo | |
| | Difference | -define= D_CFG_QE_TOOL_USE | |
| Linker | Common | -library="{workspace_loc}/{ProjName}/dsplib-rxv2/RX_DSP_FPU_LE.lib" -noprelink -form=absolute -nomessage -vect=_undefined_interrupt_source_isr -nooptimize -rom=D,R,D_1=R_1,D_2=R_2 -cpu=RAM=00000000-00007fff, FIX=00080000-00083fff,FIX=00086000-00087fff,FIX=00088000-0008dfff, FIX=00090000-0009ffff,FIX=000a0000-000bffff,FIX=000c0000-000fffff, ROM=00100000-00101fff,FIX=007fc000-007fc4ff,FIX=007ffc00-007fffff, ROM=fffc0000-fffffff -nologo | |
| | Difference | -output="rx23eb_force_qe.abs" -list=rx23eb_force_qe.map | -output="rx23eb_force_modbus.abs" -list=rx23eb_force_modbus.map |
| | Section | SU,SI,B_MODBUSDATA_HOLDREG_1, B_1,R_1,B_2,R_2,B,R/04, B_DMACH_REPEAT_AREA_1/03000, C_DATAFLASH_1/0100000, PResetPRG,C_1,C_2,C,C\$,D*,W*,L, P/0FFFC0000,EXCEPTVECT/0FFFFFFF80, RESETVECT/0FFFFFFFC | SU,SI,B_MODBUSDATA_HOLDREG_1, B_1,R_1,B_2,R_2,B,R/04, C_DATAFLASH_1/0100000, PResetPRG,C_1,C_2,C,C\$,D*,W*,L, P/0FFFC0000,EXCEPTVECT/0FFFFFFF80, RESETVECT/0FFFFFFFC |

Note: Included paths other than user settings in compiler setting are omitted.

11.1.2 Memory Usage

The amount of memory usage of the sample program is shown in Table 11-2.

Table 11-2 Amount of Memory Usage

| Item | Size [byte] | | Remarks |
|-----------------|-----------------|-------------|-----------|
| | QF for AFE ver. | Modbus ver. | |
| ROM | 12394 | 11888 | |
| | Code | 10430 | 10000 |
| | Data | 1946 | 1888 |
| E2 DataFlashROM | 170 | 170 | |
| RAM | 13618(9182) | 13368(8688) | Note |
| | Data | 8498 | 8248 |
| | Stack | 5120(684) | 5120(440) |

Note: RAM usage shown in "()" is calculated from stack usage.

11.1.3 Number of Execution Cycle and Execution Time

The number of execution cycles and processing load during measurement for each block in "Figure 8-1 Force Sensor Measurement Process Flow" are shown in Table 11-3.

Table 11-3 Number of Execution Cycles, Execution Time, and Processing Load

ICLK=32MHz

Measurement rate: 2275.312856SPS

| Item | QF for AFE version | | Modbus version | | Condition |
|-----------------------------|--------------------------------------|---------------------|--------------------------------------|---------------------|---|
| | Number of cycles (Execution time) | Processing load [%] | Number of cycles (Execution time) | Processing load [%] | |
| A/D value acquisition | 115 (3.53μs) | 0.82 | 115 (3.53μs) | 0.82 | |
| Force and torque conversion | 546 (17.06μs) | 3.88 | 546 (17.06μs) | 3.88 | |
| Communication | 729 (22.78μs) | 5.18 | 693 (21.66μs) | 5.30 | QE: Measurement result transmission process Modbus: 6ch measurement value request process |
| Others | 91 (2.84μs) | 0.65 | 23 (0.72μs) | 0.16 | |
| Total | 1457 (46.28μs) | 10.53 | 1429 (44.66μs) | 10.16 | |

Note: The processing load is calculated based on the execution time in the measurement rate.

11.2 Measurement Result

11.2.1 Measurement Appearance

Connecting a force sensor based on the configuration in “Figure 6-1 Connection of RX23E-B-QFP64-FT and Force Sensor”, we have performed measurement applying force and torque to the force sensor with evaluation jigs and weights. Figure 11-1 shows the appearance of this measurement.

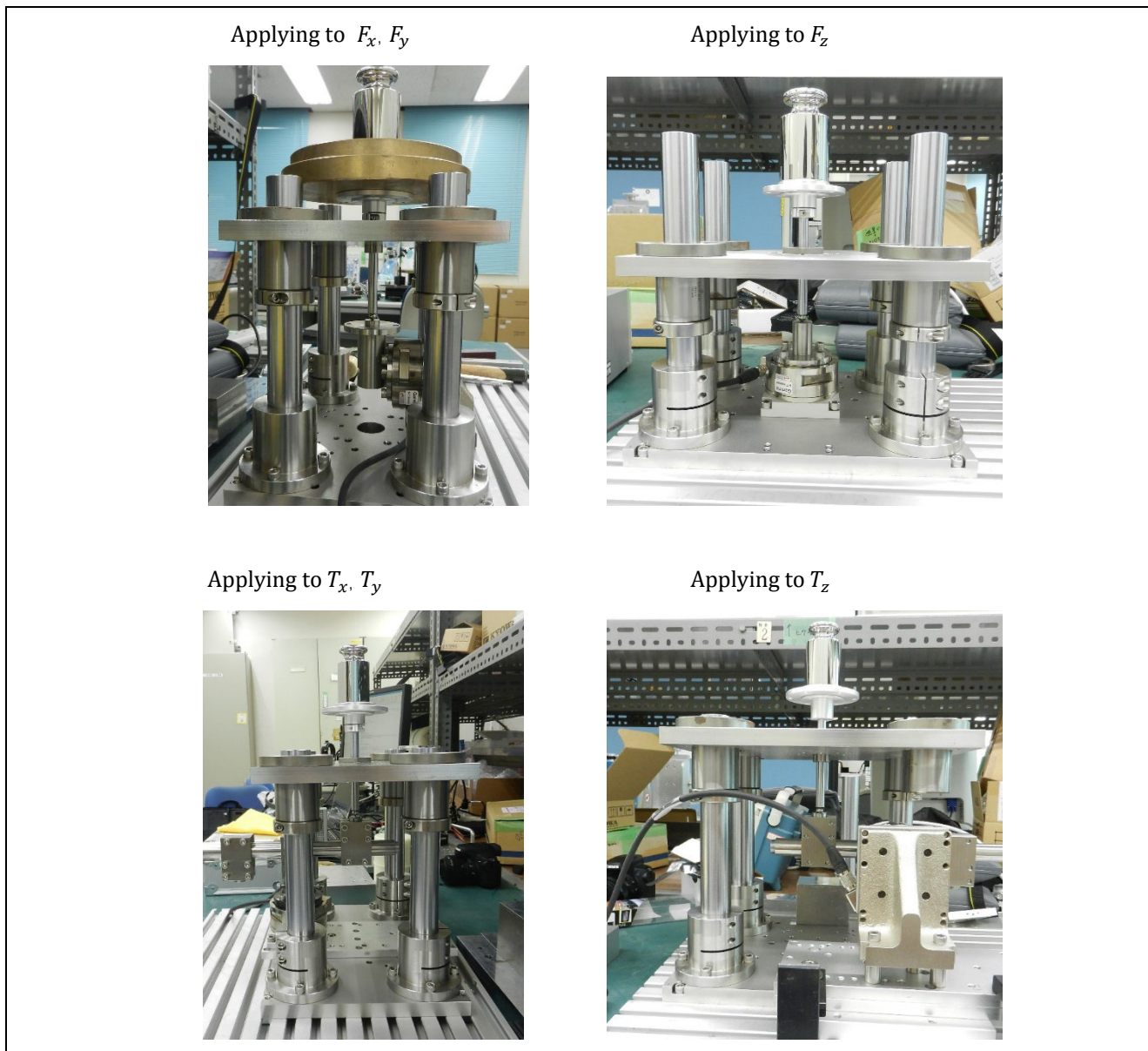


Figure 11-1 Evaluation Jigs

11.2.2 Measurement Conditions

Figure 11-2 and Figure 11-3 show how to apply force and torque, and Figure 11-4 shows the weights used in measurement.

For measurement, Zero-reset is processed in the posture shown in Figure 11-2 and Figure 11-3 at no load.

(1) Force Measurement

Force F [N] applied to a force sensor is calculated from weight m [kg] and gravitational acceleration g [m/s²] with the equation below.

$$F = m \times g$$

(2) Torque Measurement

Torque T [N·m] applied to a force sensor is calculated from weight m [kg], gravitational acceleration g [m/s²], and the distance between a fulcrum and a force point L [m] with the equation below.

$$T = m \times g \times L$$

Suppose that gravitational acceleration g is the standard gravitational acceleration 9.80665 [m/s²].

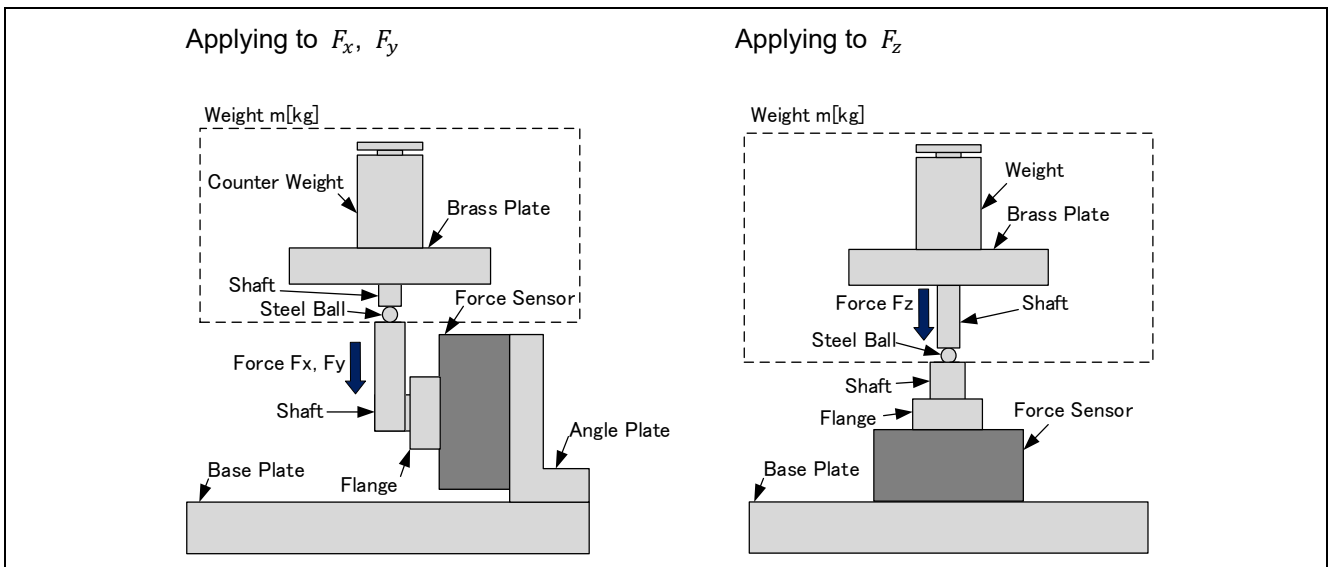


Figure 11-2 How to Apply Force

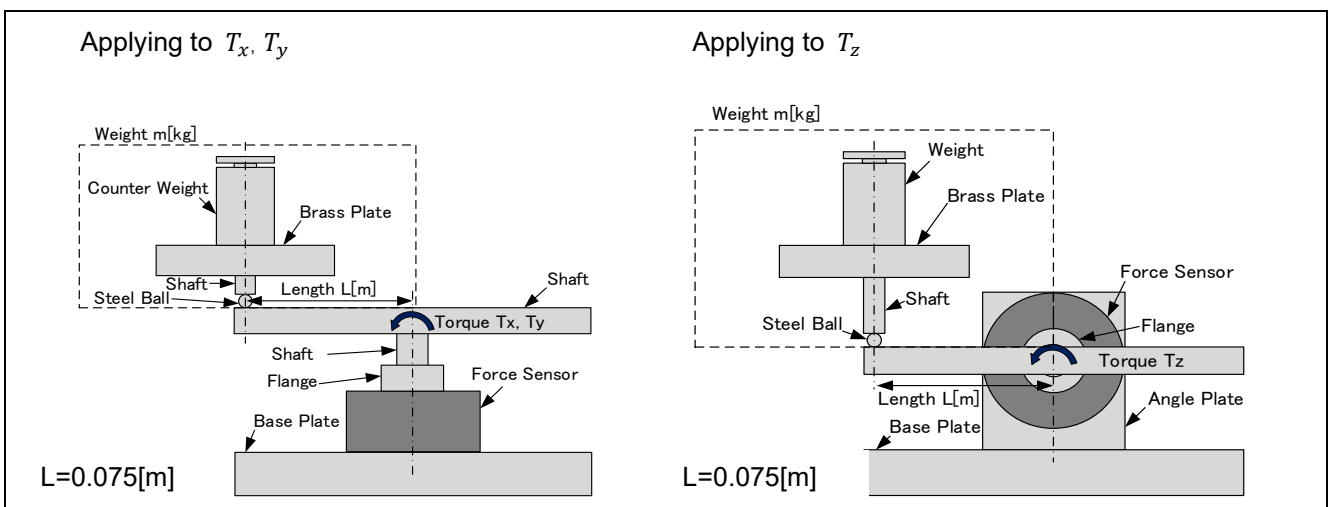


Figure 11-3 How to Apply Torque

RX23E-B Group Design and measurement of small board for 6-axis force sensor

Table 11-4 Weight Used in Measurement

| No. | Name | Model | Weight | Grade | Manufacturer |
|-----|-----------------------|-----------------|---|-------|-----------------------|
| 1 | Weight set | WS1M1K | 1mg x1, 2mg x2, 5mg x1 10mg x1, 20mg x2, 50mg x1 100mg x1, 200mg x2, 500mg x1 1g x1, 2g x2, 5g x1 10g x1, 20g x2, 50g x1 100g x1, 200g x2, 500g x1 1kg x1 | M1 | AS ONE CORPORATION |
| 2 | Cylindrical Weight | SWM2000 | 2kg | M1 | AS ONE CORPORATION |
| 3 | Brass Plate | INERTIAPLATE: C | 2.853kg ^{Note} | - | Renesas |
| 4 | Brass Plate | INERTIAPLATE: D | 4.6625kg ^{Note} | - | Renesas |

Note: Confirmed with A&D FC-5000i (A&D Company, Limited).

11.2.3 Measurement Result

The result of force measurement is shown in Figure 11-4, and the result of torque measurement is shown in Figure 11-5. The measurement results are corrected by calculating scale factor error and bias error from the measurement values at no load and at maximum load.

From the measurement result, the force measurement error $E_{F:FS}$ for full-scale is calculated from the force input value F_{in} , the force measurement value F_{mea} , and the force measurement range of the force sensor F_{FS} (F_x, F_y :130N, F_z :400N) with the equation below.

$$E_{F:FS} = \frac{F_{mea} - F_{in}}{F_{FS}} \times 100[\%FS]$$

Similarly, the torque measurement error $E_{T:FS}$ is calculated from the torque input value T_{in} , the torque measurement value T_{mea} , the torque measurement range of the force sensor T_{FS} (T_x, T_y, T_z : 10N·m) with the equation below

$$E_{T:FS} = \frac{T_{mea} - T_{in}}{T_{FS}} \times 100[\%FS]$$

Table 11-5 shows the measurement uncertainty of the force sensor 9105-TWE-Gamma used in this measurement and the full-scale error of this measurement. These errors are indicators showing the linearity of the measurement.

The force measurement error is within $\pm 0.25\%$ FS, and the torque measurement error is within $\pm 1\%$ FS, indicating that these errors are within the measurement uncertainty of the force sensor used in this measurement. Though this result contains not only the error of the circuit and the nonlinearity of the force sensor itself, but also flexure or inclination of the evaluation jigs and the error caused by friction, it is confirmed that this system configuration allows the measurement of the force sensor.

Table 11-5 Measurement Uncertainty

| Item | $E_{Fx:FS}$ [%FS] | $E_{Fy:FS}$ [%FS] | $E_{Fz:FS}$ [%FS] | $E_{Tx:FS}$ [%FS] | $E_{Ty:FS}$ [%FS] | $E_{Tz:FS}$ [%FS] |
|--|----------------------|----------------------|----------------------|----------------------|----------------------|----------------------|
| 9105-TWE-Gamma SI-130-10 Measurement uncertainty (95% CI) | 1.00% | 1.25% | 0.75% | 1.00% | 1.25% | 1.50% |
| Result of full-scale error measurement (Worst case) | 0.12% | 0.05% | 0.03% | 0.94% | 0.92% | 0.91% |

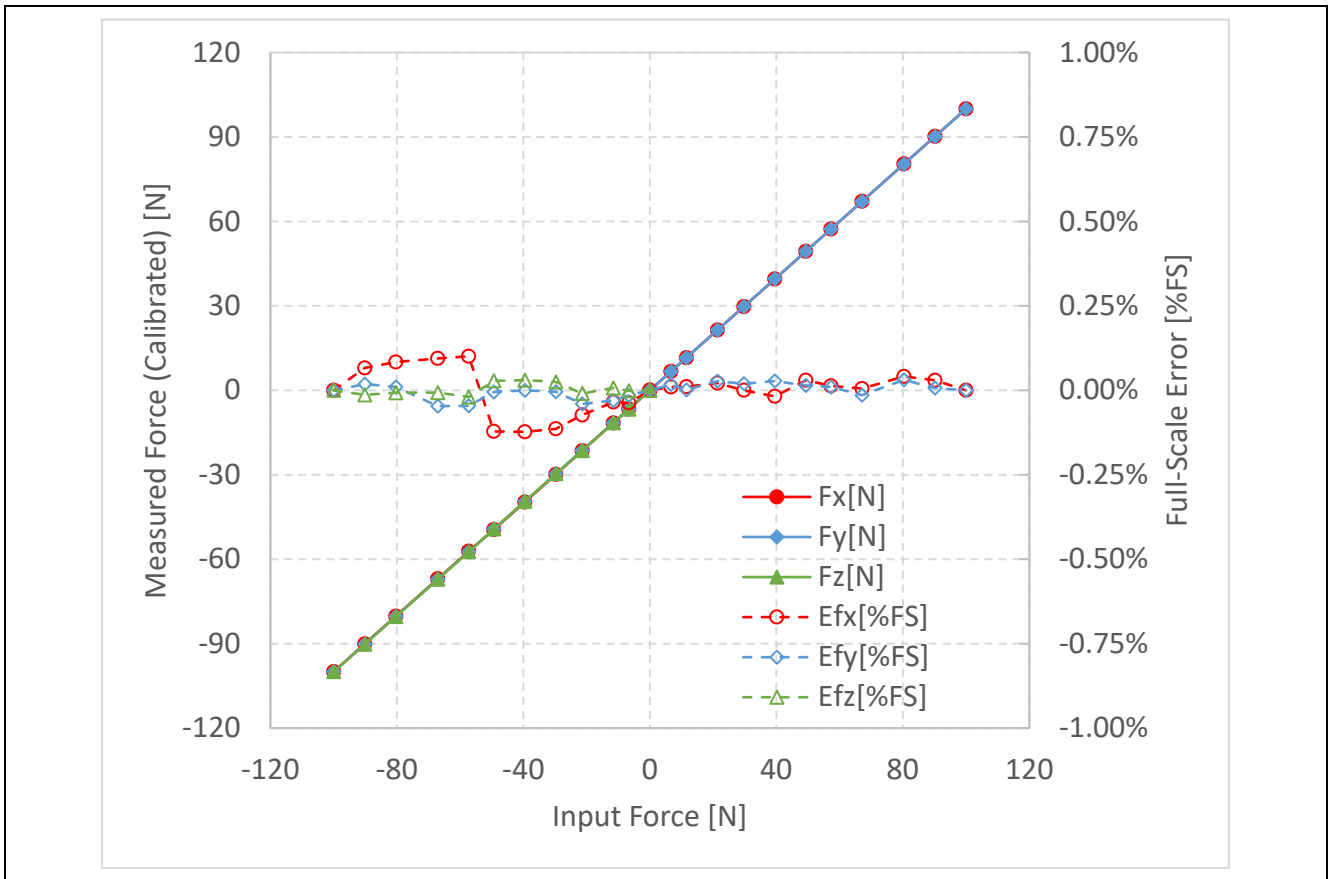


Figure 11-4 Force Measurement Result

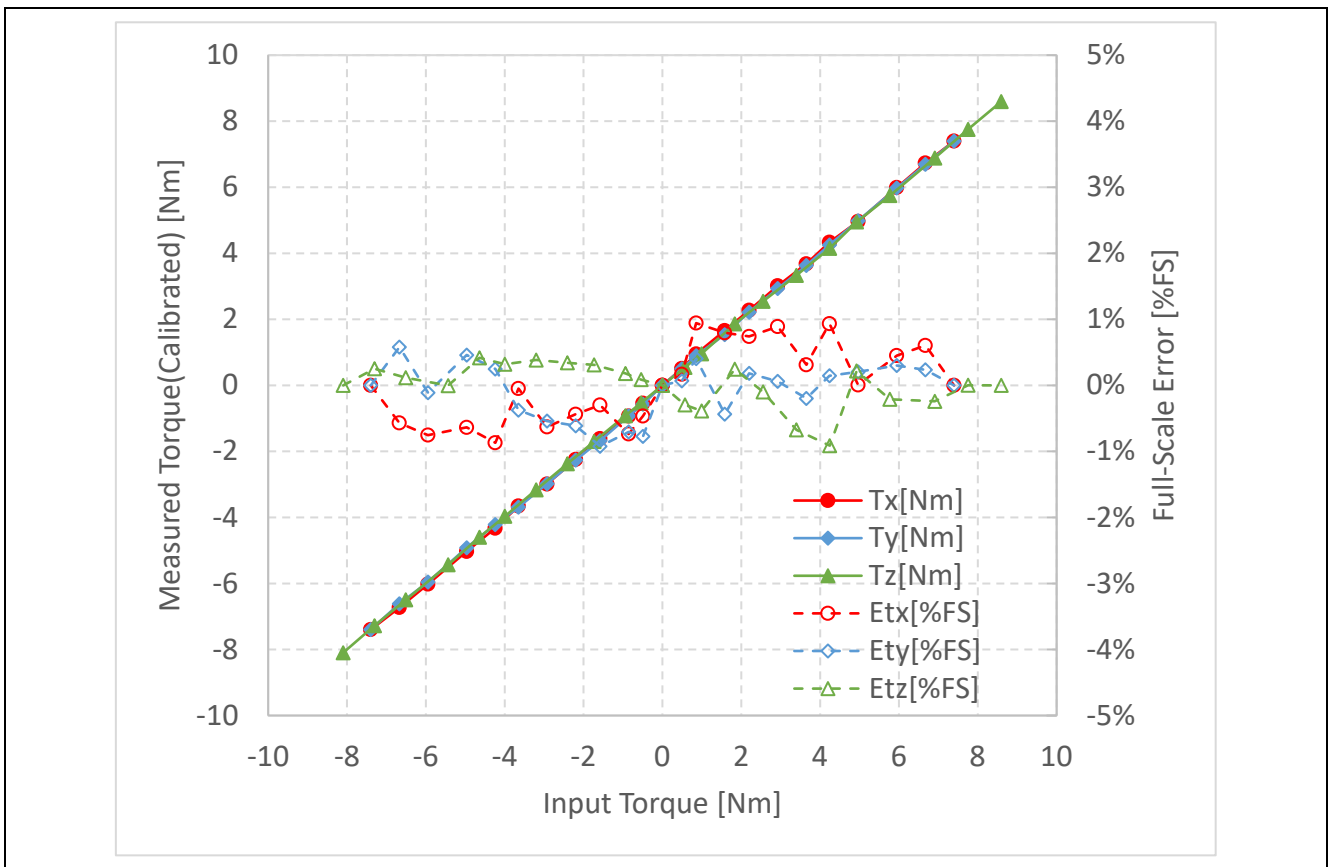


Figure 11-5 Torque Measurement Result

Revision History

| Rev. | Date | Description | |
|------|-----------|-------------|---------------|
| | | Page | Summary |
| 1.00 | Oct.23.23 | - | First release |
| | | | |

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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